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# LM12454/LM12458/LM12H458 12-Bit + Sign Data Acquisition System with Self-Calibration

# **General Description**

The LM12454, LM12458, and LM12H458 are highly integrated Data Acquisition Systems. Operating on just 5V, they combine a fully-differential self-calibrating (correcting ity and zero errors) 13-bit (12-bit + sign) analog-to converter (ADC) and sample-and-hold (S/H) with ex analog functions and digital functionality. Up to 32 co tive conversions, using two's complement format, stored in an internal 32-word (16-bit wide) FIFO data An internal 8-word RAM can store the conversion see for up to eight acquisitions through the LM12(H eight-input multiplexer. The LM12454 has a four-c multiplexer, a differential multiplexer output, and a diffe S/H input. The LM12454 and LM12(H)458 can also o with 8-bit + sign resolution and in a supervisory "wat mode that compares an input signal against two pr mable limits.

Programmable acquisition times and conversion rat possible through the use of internal clock-driven timer reference voltage input can be externally generated solute or ratiometric operation or can be derived using ternal 2.5V bandgap reference.

All registers, RAM, and FIFO are directly addre through the high speed microprocessor interface to ei 8-bit or 16-bit databus. The LM12454 and LM12(H)4 clude a direct memory access (DMA) interfac high-speed conversion data transfer.

### An evaluation/interface board is available. Order ber LM12458EVAL.

Additional applications information can be found in a tions notes AN-906, AN-947 and AN-949.

July 1999

5V, they	Desclution	10 bit i sign or 0 bit i sign	
g linear-	Resolution	12-bit + sign or 8-bit + sign	
o-digital	13-bit conversion time	8.8 μs, 5.5 μs (H) (max)	
xtensive	<ul> <li>9-bit conversion time</li> </ul>	4.2 μs, 2.6 μs (H) (max)	
onsecu- can be	13-bit Through-put rate	88k samples/s (min),	
a buffer.		140k samples/s (H) (min)	
equence	<ul> <li>Comparison time</li> </ul>	2.2 µs (max),	
H)458's	("watchdog" mode)	1.4 µs (H) (max)	
channel	■ ILE	±1 LSB (max)	
ferential	■ V <sub>IN</sub> range	GND to V <sub>A</sub> <sup>+</sup>	
operate		A	'
atchdog"	Power dissipation	30 mW, 34 mW (H) (max)	
rogram-	<ul> <li>Stand-by mode</li> </ul>	50 μW (typ)	
	<ul> <li>Single supply</li> </ul>	3V to 5.5V	1
ates are ers. The	-		
for ab-	Features		
g the in-	Three operating modes: 12 "watchdog"	-bit + sign, 8-bit + sign, and	
	<ul> <li>Single-ended or differential</li> </ul>	inputs	
essable either an	<ul> <li>Built-in Sample-and-Hold and</li> </ul>	•	
)458 in-	Instruction RAM and event	0.1	
ace for	8-channel (LM12(H)458), 4	1	
	multiplexer		
er num-	32-word conversion FIFO		
	Programmable acquisition t	imes and conversion rates	
applica-	Self-calibration and diagnos	stic mode	
appiloa	8- or 16-bit wide databus d	microprocessor or DSP	
	interface		
	Applications		
	Data Logging		1
	<ul> <li>Instrumentation</li> </ul>		1
	Process Control		
	Energy Management		
	Inertial Guidance		
			·
			1
			1
			1
			1
			1

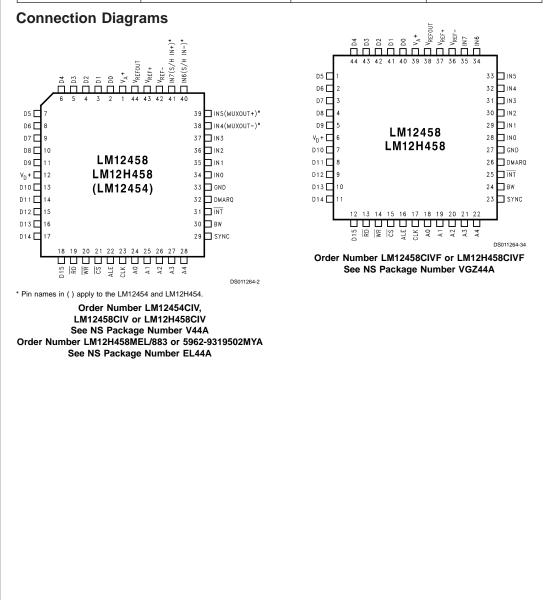
**Key Specifications** 

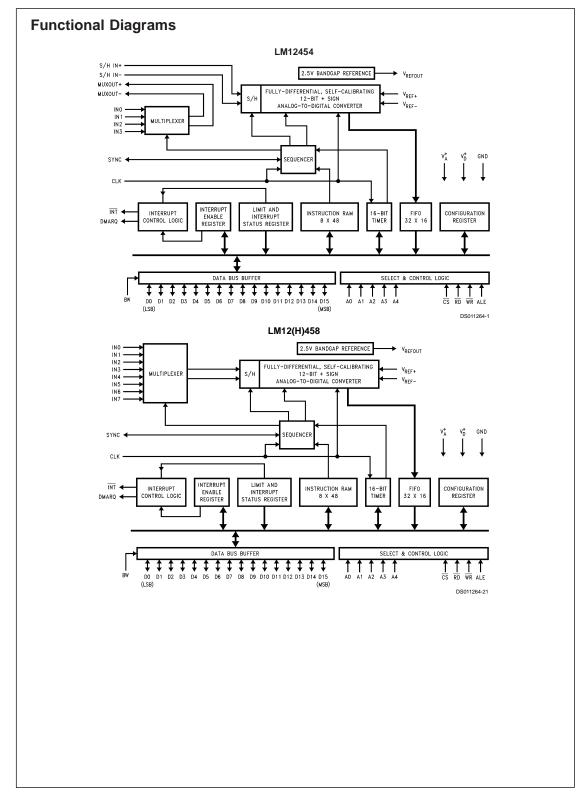
(f<sub>CLK</sub> = 5 MHz; 8 MHz, H)

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Guaranteed	Guaranteed	Order	See NS
Clock Freq (min)	Linearity Error (max)	Part Number	Package Number
8 MHz	±1.0 LSB	LM12H458CIV	V44A
		LM12H458CIVF	VGZ44A
		LM12H458MEL/883	EL44A
		or 5962-9319502MYA	
5 MHz	±1.0 LSB	LM12454CIV	V44A
		LM12458CIV	V44A
		LM12458CIVF	VGZ44A





# Absolute Maximum Ratings (Notes 1, 2)

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If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

See AN-450 "Surface Mounting Methods and Their Effect on
Product Reliability" for other methods of soldering surface
mount devices.

# Operating Ratings (Notes 1, 2)

Supply Voltage (V <sub>A</sub> + and V <sub>D</sub> +)	6.0V
Voltage at Input and Output Pins	
except IN0-IN3 (LM12454)	-0.3V to V <sup>+</sup> + 0.3V
and IN0–IN7 (LM12(H)458)	
Voltage at Analog Inputs IN0-IN3 (L	_M12454)
and IN0–IN7 (LM12(H)458)	GND – 5V to V <sup>+</sup> + 5V
$ V_A + - V_D + $	300 mV
Input Current at Any Pin (Note 3)	±5 mA
Package Input Current (Note 3)	±20 mA
Power Dissipation ( $T_A = 25^{\circ}C$ )	
V Package (Note 4)	875 mW
Storage Temperature	-65°C to +150°C
Lead Temperature	
V Package, Infrared, 15 sec.	+300°C
EL and W Packages,	
Solder, 10 sec.	+250°C
ESD Susceptibility (Note 5)	1.5 kV
LM12458MEL/883	2.0 kV

Temperature Range $(T_{min} \le T_A \le T_{max})$ LM12454CIV/	
LM12(H)458CIV	$-40^{\circ}C \le T_A \le 85^{\circ}C$
LM12458MEL/883	$-55^{\circ}C \le T_{A} \le 125^{\circ}C$
Supply Voltage	
V <sub>A</sub> +, V <sub>D</sub> +	3.0V to 5.5V
$ V_{A} + - V_{D} + $	≤100 mV
V <sub>IN+</sub> Input Range	$GND \leq V_{IN+} \leq V_{A}$ +
V <sub>IN-</sub> Input Range	$GND \le V_{IN-} \le V_A +$
V <sub>REF+</sub> Input Voltage	$1V \le V_{REF+} \le V_{A}+$
V <sub>REF</sub> _ Input Voltage	$0V \le V_{REF-} \le V_{REF+} - 1V$
$V_{REF+} - V_{REF-}$	$1V \le V_{REF} \le V_A +$
V <sub>REF</sub> Common Mode	
Range (Note 16)	0.1 $V_A^+ \leq V_{REFCM} \leq 0.6 V_A^+$

# Converter Characteristics (Notes 6, 7, 8, 9, 19)

The following specifications apply to the LM12454, LM12458, and LM12H458 for  $V_A + = V_D + = 5V$ ,  $V_{REF+} = 5V$ ,  $V_{REF-} = 0V$ , 12-bit + sign conversion mode,  $f_{CLK} = 8.0$  MHz (LM12H458) or  $f_{CLK} = 5.0$  MHz (LM12454/8),  $R_S = 25\Omega$ , source impedance for  $V_{REF+}$  and  $V_{REF+} \leq 25\Omega$ , fully-differential input with fixed 2.5V common-mode voltage, and minimum acquisition time unless otherwise specified. Boldface limits apply for  $T_A = T_J = T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A = T_J = 25^{\circ}C$ .

Symbol	Parameter	Conditions	Typical	Limits	Unit
			(Note 10)	(Note 11)	(Limit)
ILE	Positive and Negative Integral	After Auto-Cal (Notes 12, 17)	±1/2	±1	LSB (max)
	Linearity Error				
TUE	Total Unadjusted Error	After Auto-Cal (Note 12)	±1		LSB
	Resolution with No Missing Codes	After Auto-Cal (Note 12)		13	Bits (max)
DNL	Differential Non-Linearity	After Auto-Cal		±3⁄4	LSB (max)
	Zero Error	After Auto-Cal (Notes 13, 17)		±1	
		LM12H458	±1/2	±1.5	LSB (max)
	Positive Full-Scale Error	After Auto-Cal (Notes 12, 17)	±1/2	±2	LSB (max)
		LM12(H)458MEL		±2.5	
	Negative Full-Scale Error	After Auto-Cal (Notes 12, 17)	±1/2	±2	LSB (max)
		LM12(H)458MEL		±2.5	
	DC Common Mode Error	(Note 14)	±2	±3.5	LSB (max)
ILE	8-Bit + Sign and "Watchdog"	(Note 12)			
	Mode Positive and Negative			±1/2	LSB (max)
	Integral Linearity Error				
TUE	8-Bit + Sign and "Watchdog" Mode	After Auto-Zero	±1/2	±3/4	LSB (max)
	Total Unadjusted Error				
	8-Bit + Sign and "Watchdog" Mode			9	Bits (max)
	Resolution with No Missing Codes				
DNL	8-Bit + Sign and "Watchdog" Mode			±3/4	LSB (max)
	Differential Non-Linearity				
	8-Bit + Sign and "Watchdog" Mode	After Auto-Zero		±1/2	LSB (max)
	Zero Error				
	8-Bit + Sign and "Watchdog" Positive	1		±1/2	LSB (max)
	and Negative Full-Scale Error				

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Conver	ter Characteristics (Notes 6,	7, 8, 9, 19) (Continued)			
12-bit + sign	specifications apply to the LM12454, LN conversion mode, $f_{CLK} = 8.0 \text{ MHz}$ (LM1: REF_ $\leq 25\Omega$ , fully-differential input with fixecified. Boldface limits apply for $T_A = 1000$	2H458) or fork = 5.0 MHz (LM12454/8	3). $R_{s} = 25\Omega$	source imp	edance for
Symbol	Parameter	Conditions	Typical	Limits	Unit
			(Note 10)	(Note 11)	(Limit)
	8-Bit + Sign and "Watchdog" Mode		±1/8		LSB
	DC Common Mode Error				
	Multiplexer Channel-to-Channel		±0.05		LSB
	Matching				
V <sub>IN+</sub>	Non-Inverting Input Range			GND	V (min)
				V <sub>A</sub> +	V (max)
V <sub>IN-</sub>	Inverting Input Range			GND	V (min)
				V <sub>A</sub> +	V (max)
$V_{IN+} - V_{IN-}$	Differential Input Voltage Range			-V <sub>A</sub> +	V (min)
				V <sub>A</sub> +	V (max)
$V_{IN+} - V_{IN-}$	Common Mode Input Voltage Range			GND	V (min)
2				V <sub>A</sub> +	V (max)
PSS	Power Supply Zero Error	$V_{A}$ + = $V_{D}$ + = 5V ±10%	±0.2	±1.75	LSB (max)
	Sensitivity Full-Scale Error	$V_{REF+} = 4.5V, V_{REF-} = GND$	±0.4	±2	LSB (max)
	(Note 15) Linearity Error		±0.2		LSB
C <sub>REF</sub>	V <sub>REF+</sub> /V <sub>REF-</sub> Input Capacitance		85		pF
C <sub>IN</sub>	Selected Multiplexer Channel Input		75		pF
	Capacitance				

**Converter AC Characteristics** (Notes 6, 7, 8, 9, 19) The following specifications apply to the LM12454, LM12458, and LM12H458 for  $V_A + = V_D + = 5V$ ,  $V_{REF+} = 5V$ ,  $V_{REF-} = 0V$ , 12-bit + sign conversion mode,  $f_{CLK} = 8.0$  MHz (LM12H458) or  $f_{CLK} = 5.0$  MHz (LM12454/8),  $R_S = 25\Omega$ , source impedance for  $V_{REF+}$  and  $V_{REF-} \le 25\Omega$ , fully-differential input with fixed 2.5V common-mode voltage, and minimum acquisition time unless otherwise specified. Boldface limits apply for  $T_A = T_J = T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A = T_J = 25^{\circ}C$ .

Symbol	Parameter	Conditions	Typical	Limits	Unit
			(Note 10)	(Note 11)	(Limit)
	Clock Duty Cycle		50		%
				40	% (min)
				60	%
					(max)
t <sub>c</sub>	Conversion Time	13-Bit Resolution,	44 (t <sub>CLK</sub> )	44 (t <sub>CLK</sub> ) + 50 ns	(max)
		Sequencer State S5 (Figure 15)			
		9-Bit Resolution,	21 (t <sub>CLK</sub> )	21 (t <sub>cLK</sub> ) + 50 ns	(max)
		Sequencer State S5 (Figure 15)			
t <sub>A</sub>	Acquisition Time	Sequencer State S7 (Figure 15)	9 (t <sub>ськ</sub> )	9 (t <sub>с∟к</sub> ) + 50 ns	(max)
		Built-in minimum for 13-Bits			
		Built-in minimum for 9-Bits and	2 (t <sub>CLK</sub> )	2 (t <sub>CLK</sub> ) + 50 ns	(max)
		"Watchdog" mode			
tz	Auto-Zero Time	Sequencer State S2 (Figure 15)	76 (t <sub>CLK</sub> )	76 (t <sub>CLK</sub> ) + 50 ns	(max)
t <sub>CAL</sub>	Full Calibration Time	Sequencer State S2 (Figure 15)	4944 (t <sub>CLK</sub> )	4944 (t <sub>ськ</sub> ) + 50 ns	(max)
	Throughput Rate		89	88	kHz
	(Note 18)	LM12H458	142	140	(min)
t <sub>WD</sub>	"Watchdog" Mode Comparison	Sequencer States S6, S4,	11 (t <sub>ськ</sub> )	11 (t <sub>cLK</sub> ) + 50 ns	(max)
	Time	and S5 ( <i>Figure 15</i> )			

12-bit + s V <sub>REF+</sub> and otherwise	wing specifications apply to the LM1 ign conversion mode, $f_{CLK} = 8.0 \text{ M}$ d $V_{REF-} \le 25\Omega$ , fully-differential input specified. <b>Boldface limits apply for</b>	Tz (LM12H458) or $f_{CLK} = 5.0 \text{ M}$ it with fixed 2.5V common-mode or $T_A = T_J = T_{MIN}$ to $T_{MAX}$ ; all c	Hz (LM12454/8), $R_s =$ voltage, and minimu other limits $T_A = T_J =$	= 25Ω, source imperimentation time 25°C.	e_ = 0v, edance for unless
Symbol	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Unit
DSNR	Differential Signal-to-Noise Ratio	$V_{IN} = \pm 5V$	(Note 10)		(Limi
DONIN		$f_{IN} = 1 \text{ kHz}$	77.5		dB
		$f_{IN} = 20 \text{ kHz}$	75.2		dB
		$f_{IN} = 40 \text{ kHz}$	74.7		dB
SESNR	Single-Ended Signal-to-Noise	$V_{IN} = 5 V_{p-p}$			
	Ratio	$f_{IN} = 1 \text{ kHz}$	69.8		dB
		$f_{IN} = 20 \text{ kHz}$	69.2		dB
		$f_{IN} = 40 \text{ kHz}$	66.6		dB
DSINAD	Differential Signal-to-Noise +	$V_{IN} = \pm 5V$			
	Distortion Ratio	$f_{IN} = 1 \text{ kHz}$	76.9		dB
		$f_{IN} = 20 \text{ kHz}$	73.9		dB
		$f_{IN} = 40 \text{ kHz}$	70.7		dB
SESINAD	Single-Ended Signal-to-Noise +	$V_{IN} = 5 V_{p-p}$	10.1		
020111/12	Distortion Ratio	$f_{IN} = 1 \text{ kHz}$	69.4		dB
		$f_{IN} = 20 \text{ kHz}$	68.3		dB
		$f_{IN} = 40 \text{ kHz}$	65.7		dB
DTHD	Differential Total Harmonic	$V_{IN} = \pm 5V$	00.1		
DIIID	Distortion	$f_{IN} = 1 \text{ kHz}$	-85.8		dB
	Distortion	$f_{IN} = 20 \text{ kHz}$	-79.9		dB
		$f_{IN} = 40 \text{ kHz}$	-72.9		dB
SETHD	Single-Ended Total Harmonic	$V_{\rm IN} = 5 V_{\rm p-p}$	-12.5		
OLIND	Distortion	$f_{IN} = 1 \text{ kHz}$	-80.3		dB
	Distortion	$f_{IN} = 20 \text{ kHz}$	-75.6		dB
		$f_{IN} = 40 \text{ kHz}$	-72.8		dB
DENOB	Differential Effective Number	$V_{IN} = \pm 5V$	-72.0		
DLINOD	of Bits	$f_{IN} = 1 \text{ kHz}$	12.6		Bits
		$f_{IN} = 20 \text{ kHz}$	12.0		Bits
			12.2		Bits
SEENOB	Single Ended Effective Number	$f_{IN} = 40 \text{ kHz}$	12.1		
SEENUD	Single-Ended Effective Number	$V_{\rm IN} = 5 V_{\rm p-p}$	11.2		Dito
	of Bits	$f_{IN} = 1 \text{ kHz}$	11.3		Bits
		$f_{IN} = 20 \text{ kHz}$			Bits
	Differential Courieus Free	$f_{IN} = 40 \text{ kHz}$	10.8		Bits
DSFDR	Differential Spurious Free	$V_{\rm IN} = \pm 5V$	07.0		
	Dynamic Range	$f_{IN} = 1 \text{ kHz}$	87.2		dB
		$f_{IN} = 20 \text{ kHz}$	78.9		dB
	Multiplaces Observation Observation	$f_{IN} = 40 \text{ kHz}$	72.8		dB
	Multiplexer Channel-to-Channel	$V_{\rm IN} = 5 V_{\rm PP}$			
	Crosstalk	$f_{IN} = 40 \text{ kHz}$	70		-10
		LM12454 MUXOUT Only	-76		dB
		LM12(H)458 MUX	-78		dB
	Device the Time	plus Converter			_
PU	Power-Up Time		10		ms
WU	Wake-Up Time		10		ms

	lowing specifications apply to the LM12454, LM 8.0 MHz (LM12H454/8) or $f_{CLK} = 5.0$ MHz (LM nits apply for $T_A = T_J = T_{MIN}$ to $T_{MAX}$ ; all oth Parameter	Conditions			
Symbol	Parameter	Conditions	Typical (Note 10)	Limits (Note 11)	Unit (Limit)
I <sub>D</sub> +	V <sub>D</sub> + Supply Current	$\overline{CS} = "1"$	(11010-10)		(Emility
.0.		LM12454/8	0.55	1.0	mA (max)
		LM12H458	0.55	1.2	
I <sub>A</sub> +	V <sub>A</sub> + Supply Current	<u>CS</u> = "1"			
~		LM12454/8	3.1	5.0	mA (max)
		LM12H458	3.1	5.5	
I <sub>ST</sub>	Stand-By Supply Current $(I_D + + I_A +)$	Power-Down Mode Selected			
.51		Clock Stopped	10		µA (max)
		8 MHz Clock	40		µA (max)
	Multiplexer ON-Channel Leakage Current	V <sub>4</sub> + = 5.5V	-		r ( ··· /
		ON-Channel = 5.5V		0.3	
		OFF-Channel = 0V	0.1		µA (max)
		LM12(H)458MEL		0.5	1 ( )
		ON-Channel = 0V		0.3	
		OFF-Channel = 5.5V	0.1		µA (max)
		LM12(H)458MEL		0.5	,
	Multiplexer OFF-Channel Leakage Current	V <sub>A</sub> + = 5.5V			
		ON-Channel = 5.5V		0.3	
		OFF-Channel = 0V	0.1		µA (max)
		LM12(H)458MEL		0.5	
		ON-Channel = 0V		0.3	
		OFF-Channel = 5.5V	0.1		µA (max)
		LM12(H)458MEL		0.5	
R <sub>ON</sub>	Multiplexer ON-Resistance	LM12454			
		$V_{IN} = 5V$	800	1500	Ω(max)
		V <sub>IN</sub> = 2.5V	850	1500	Ω(max)
		$V_{IN} = 0V$	760	1500	Ω(max)
	Multiplexer Channel-to-Channel	LM12454			
	R <sub>ON</sub> matching	V <sub>IN</sub> = 5V	±1.0%	±3.0%	(max)
		V <sub>IN</sub> = 2.5V	±1.0%	±3.0%	(max)
		$V_{IN} = 0V$	±1.0%	±3.0%	(max)

Internal Reference Characteristics (Notes 6, 7, 19) The following specifications apply to the LM12454, LM12458, and LM12H458 for  $V_A$ + =  $V_D$ + = 5V unless otherwise specified. Boldface limits apply for  $T_A = T_J = T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A = T_J = 25^{\circ}C$ .

Symbol	Parameter	Conditions	Typical	Limits	Unit
			(Note 10)	(Note 11)	(Limit)
V <sub>REFOUT</sub>	Internal Reference Output Voltage		2.5	2.5 ±4%	V (max)
		LM12(H)458MEL		2.5 ±6%	
$\Delta V_{REF} / \Delta T$	Internal Reference Temperature		40		ppm/°C
	Coefficient				
$\Delta_{REF}/\Delta I_{L}$	Internal Reference Load Regulation	Sourcing (0 < $I_L \le +4$ mA)		0.2	%/mA (max)
		Sinking (-1 $\leq$ I <sub>IL</sub> < 0 mA)		1.2	%/mA (max)
$\Delta V_{REF}$	Line Regulation	$4.5V \le V_A + \le 5.5V$	3	20	mV (max)
I <sub>SC</sub>	Internal Reference Short Circuit Current	V <sub>REFOUT</sub> = 0V	13	25	mA (max)
$\Delta V_{REE}/\Delta t$	Long Term Stability		200		ppm/kHr

# Internal Reference Characteristics (Notes 6, 7, 19) (Continued)

The following specifications apply to the LM12454, LM12458, and LM12H458 for  $V_A$ + =  $V_D$ + = 5V unless otherwise specified. Boldface limits apply for  $T_A = T_J = T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A = T_J = 25^{\circ}C$ .

Symbol	Parameter	Conditions	Typical	Limits	Unit
			(Note 10)	(Note 11)	(Limit)
t <sub>su</sub>	Internal Reference Start-Up Time	$V_A$ + = $V_D$ + = 0V $\rightarrow$ 5V	10		ms
		C <sub>L</sub> = 100 μF			

# Digital Characteristics (Notes 6, 7, 8, 19)

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The following specifications apply to the LM12454, LM12458, and LM12H458 for  $V_A$  =  $V_D$  = 5V, unless otherwise specified. **Boldface limits apply for T\_A = T\_J = T\_{MIN} to T\_{MAX}**; all other limits  $T_A = T_J = 25^{\circ}C$ .

Symbol	Parameter	Conditions	Typical	Limits	Unit
			(Note 10)	(Note 11)	(Limit)
V <sub>IN(1)</sub>	Logical "1" Input Voltage	$V_{A}$ + = $V_{D}$ + = 5.5V		2.0	V (min)
V <sub>IN(0)</sub>	Logical "0" Input Voltage	$V_{A}$ + = $V_{D}$ + = 4.5V		0.8	V (max)
I <sub>IN(1)</sub>	Logical "1" Input Current	$V_{IN} = 5V$	0.005	1.0	μA (max)
		LM12(H)458MEL		2.0	
I <sub>IN(0)</sub>	Logical "0" Input Current	$V_{IN} = 0V$	-0.005	-1.0	μA (max)
		LM12(H)458MEL		-2.0	
CIN	D0-D15 Input Capacitance		6		pF
V <sub>OUT(1)</sub>	Logical "1" Output Voltage	$V_{A}$ + = $V_{D}$ + = 4.5V			
		I <sub>OUT</sub> = -360 μA		2.4	V (min)
		I <sub>OUT</sub> = -10 μA		4.25	V (min)
V <sub>OUT(0)</sub>	Logical "0" Output Voltage	$V_{A}$ + = $V_{D}$ + = 4.5V		0.4	V (max)
		I <sub>OUT</sub> = 1.6 mA			
I <sub>OUT</sub>	TRI-STATE <sup>®</sup> Output Leakage Current	V <sub>OUT</sub> = 0V	-0.01	-3.0	μA (max)
		V <sub>OUT</sub> = 5V	0.01	3.0	μA (max)

**Digital Timing Characteristics** (Notes 6, 7, 8, 19) The following specifications apply to the LM12454, LM12458, and LM12H458 for  $V_A$ + =  $V_D$ + = 5V,  $t_r$  =  $t_f$  = 3 ns, and  $C_L$  = 100 pF on data I/O, INT and DMARQ lines unless otherwise specified. Boldface limits apply for  $T_A$  =  $T_J$  =  $T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A$  =  $T_J$  = 25°C.

Symbol	Parameter	Conditions	Typical	Limits	Unit
(See Figures 8, 9, 10)			(Note 10)	(Note 11)	(Limit)
1, 3	CS or Address Valid to ALE Low			40	ns (min)
	Set-Up Time				
2, 4	CS or Address Valid to ALE Low			20	ns (min)
	Hold Time				
5	ALE Pulse Width			45	ns (min)
6	RD High to Next ALE High			35	ns (min)
7	ALE Low to RD Low			20	ns (min)
8	RD Pulse Width			100	ns (min)
9	RD High to Next RD or WR Low			100	ns (min)
10	ALE Low to WR Low			20	ns (min)
11	WR Pulse Width			60	ns (min)
12	WR High to Next ALE High			75	ns (min)
13	WR High to Next RD or WR Low			140	ns (min)
14	Data Valid to WR High Set-Up Time			40	ns (min)
15	Data Valid to WR High Hold Time			30	ns (min)
16	RD Low to Data Bus Out of TRI-STATE		40	10	ns (min)
				70	ns (max

# Digital Timing Characteristics (Notes 6, 7, 8, 19) (Continued)

The following specifications apply to the LM12454, LM12458, and LM12H458 for  $V_A$ + =  $V_D$ + = 5V,  $t_r$  =  $t_f$  = 3 ns, and  $C_L$  = 100 pF on data I/O, INT and DMARQ lines unless otherwise specified. **Boldface limits apply for T\_A = T\_J = T\_{MIN} to T\_{MAX}**; all other limits  $T_A = T_J = 25^{\circ}C$ .

Symbol	Parameter	Conditions	Typical	Limits	Unit
(See Figures 8, 9, 10)			(Note 10)	(Note 11)	(Limit)
17	RD High to TRI-STATE	$R_L = 1 k\Omega$	30	10	ns (min)
				110	ns (max)
18	RD Low to Data Valid (Access Time)		30	10	ns (min)
				80	ns (max)
20	Address Valid or CS Low to RD Low			20	ns (min)
21	Address Valid or $\overline{CS}$ Low to $\overline{WR}$ Low			20	ns (min)
19	Address Invalid			10	ns (min)
	from RD or WR High				
22	INT High from RD Low		30	10	ns (min)
				60	ns (max)
23	DMARQ Low from RD Low		30	10	ns (min)
				60	ns (max)

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

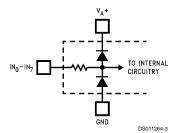
Note 2: All voltages are measured with respect to GND, unless otherwise specified.

**Note 3:** When the input voltage ( $V_{IN}$ ) at any pin exceeds the power supply rails ( $V_{IN} < GND$  or  $V_{IN} > (V_A + or V_D +)$ ), the current at that pin should be limited to 5 mA. The 20 mA maximum package input current rating allows the voltage at any four pins, with an input current of 5 mA, to simultaneously exceed the power supply voltages.

Note 4: The maximum power dissipation must be derated at elevated temperatures and is dictated by  $T_{Jmax}$  (maximum junction temperature),  $\theta_{JA}$  (package junction to ambient thermal resistance), and  $T_A$  (ambient temperature). The maximum allowable power dissipation at any temperature is  $PD_{max} = (T_{Jmax} - T_A)/\theta_{JA}$  or the number given in the Absolute Maximum Ratings, whichever is lower. For this device,  $T_{Jmax} = 150$ °C, and the typical thermal resistance ( $\theta_{JA}$ ) of the LM12454 and LM12(H)458 in the V package, when board mounted, is 47°C/W, in the W package, when board mounted, is 50°C/W ( $\theta_{JC} = 5.8$ °C/W), and in the EL package, when board mounted, is 70°C/W ( $\theta_{JC} = 3.5$ °C/W).

Note 5: Human body model, 100 pF discharged through a 1.5 k $\!\Omega$  resistor.

Note 6: Two on-chip diodes are tied to each analog input through a series resistor, as shown below. Input voltage magnitude up to 5V above  $V_A$ + or 5V below GND will not damage the LM12454 or the LM12(H)458. However, errors in the A/D conversion can occur if these diodes are forward biased by more than 100 mV. As an example, if  $V_A$ + is 4.5  $V_{DC}$ , full-scale input voltage must be  $\leq 4.6 V_{DC}$  to ensure accurate conversions.



Note 7:  $V_A$ + and  $V_D$ + must be connected together to the same power supply voltage and bypassed with separate capacitors at each V<sup>+</sup> pin to assure conversion/ comparison accuracy.

Note 8: Accuracy is guaranteed when operating at f<sub>CLK</sub> = 5 MHz for the LM12454/8 and f<sub>CLK</sub> = 8 MHz for the LM12H458.

Note 9: With the test condition for  $V_{REF}$  ( $V_{REF+} - V_{REF-}$ ) given as +5V, the 12-bit LSB is 1.22 mV and the 8-bit/"Watchdog" LSB is 19.53 mV.

Note 10: Typicals are at T<sub>A</sub> = 25°C and represent most likely parametric norm.

Note 11: Limits are guaranteed to National's AOQL (Average Output Quality Level).

Note 12: Positive integral linearity error is defined as the deviation of the analog value, expressed in LSBs, from the straight line that passes through positive full-scale and zero. For negative integral linearity error the straight line passes through negative full-scale and zero. (See *Figure 6 Figure 7*).

Note 13: Zero error is a measure of the deviation from the mid-scale voltage (a code of zero), expressed in LSB. It is the worst-case value of the code transitions between -1 to 0 and 0 to +1 (see Figure 8).

Note 14: The DC common-mode error is measured with both inputs shorted together and driven from 0V to 5V. The measured value is referred to the resulting output value when the inputs are driven with a 2.5V signal.

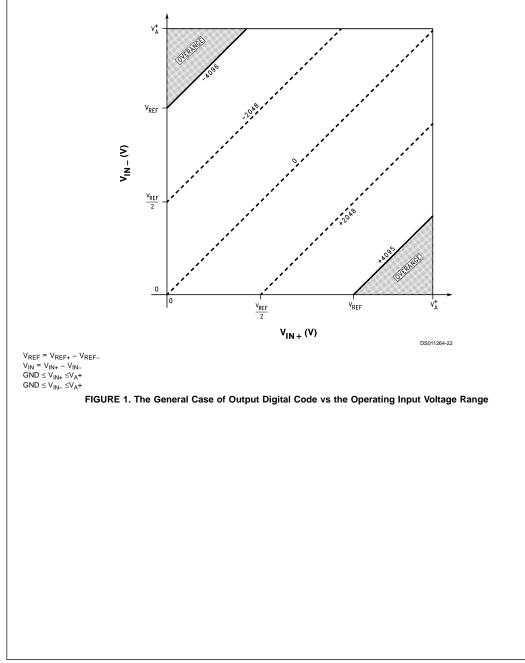
Note 15: Power Supply Sensitivity is measured after Auto-Zero and/or Auto-Calibration cycle has been completed with V<sub>A</sub>+ and V<sub>D</sub>+ at the specified extremes. Note 16: V<sub>REFCM</sub> (Reference Voltage Common Mode Range) is defined as (V<sub>REF+</sub> + V<sub>REF-</sub>)/2.

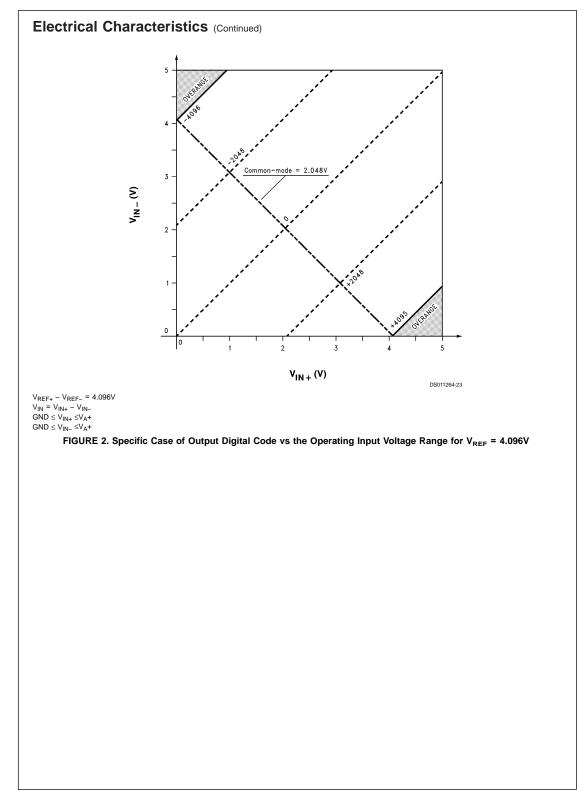
# Digital Timing Characteristics (Notes 6, 7, 8, 19) (Continued)

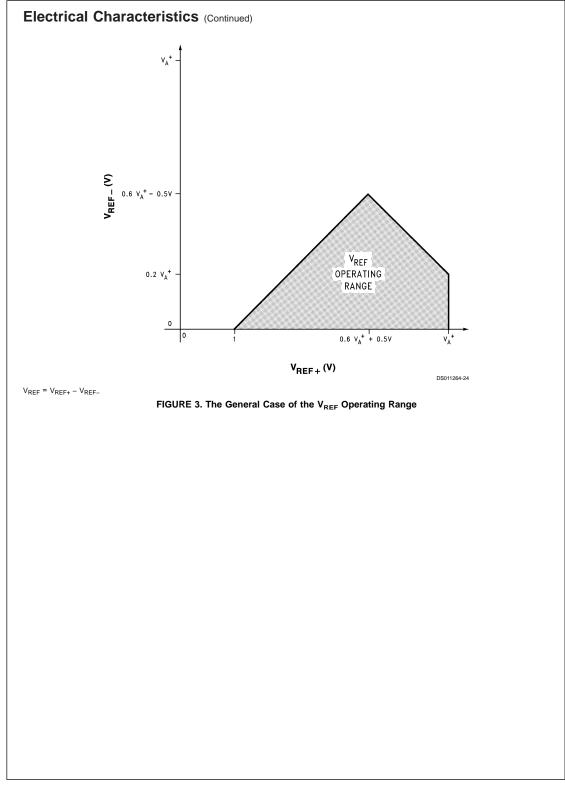
Note 17: The LM12(H)454/8's self-calibration technique ensures linearity and offset errors as specified, but noise inherent in the self-calibration process will result in a repeatability uncertainty of ±0.10 LSB.

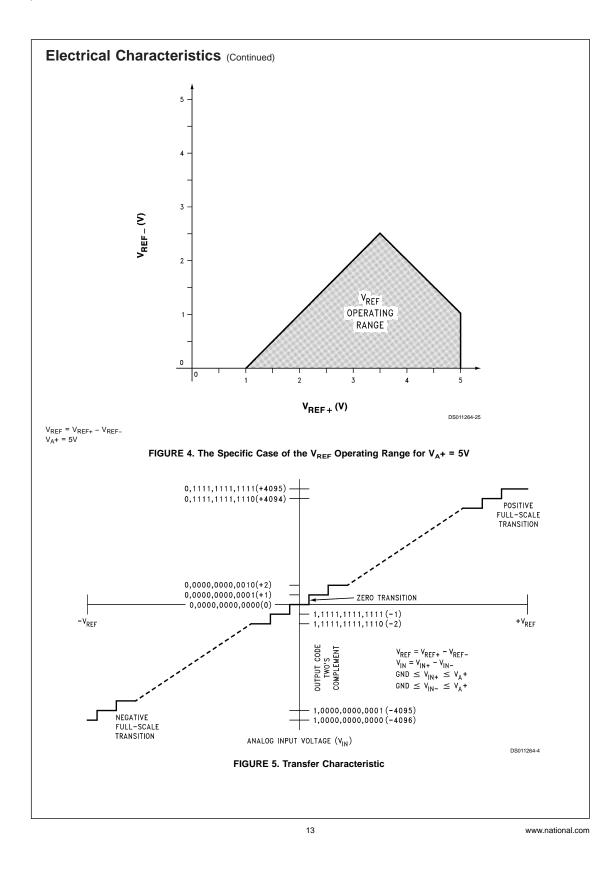
Note 18: The Throughput Rate is for a single instruction repeated continuously. Sequencer states 0 (1 clock cycle), 1 (1 clock cycle), 7 (9 clock cycles) and 5 (44 clock cycles) are used (see *Figure 15*). One additional clock cycle is used to read the conversion result stored in the FIFO, for a total of 56 clock cycles per conversion. The Throughput Rate is f<sub>CLK</sub> (MHz)/N, where N is the number of clock cycles/conversion. Note 19: A military RETS specification is available upon request.

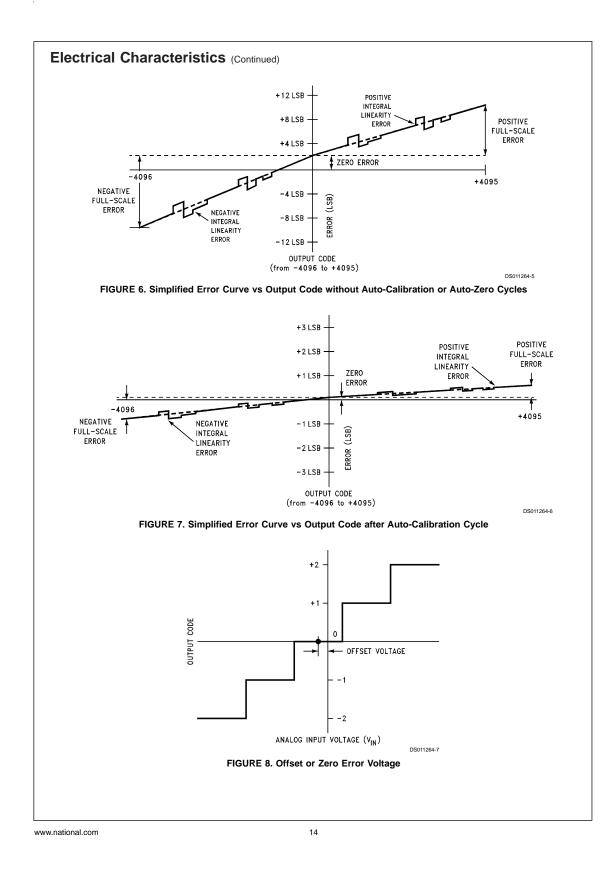
# **Electrical Characteristics**

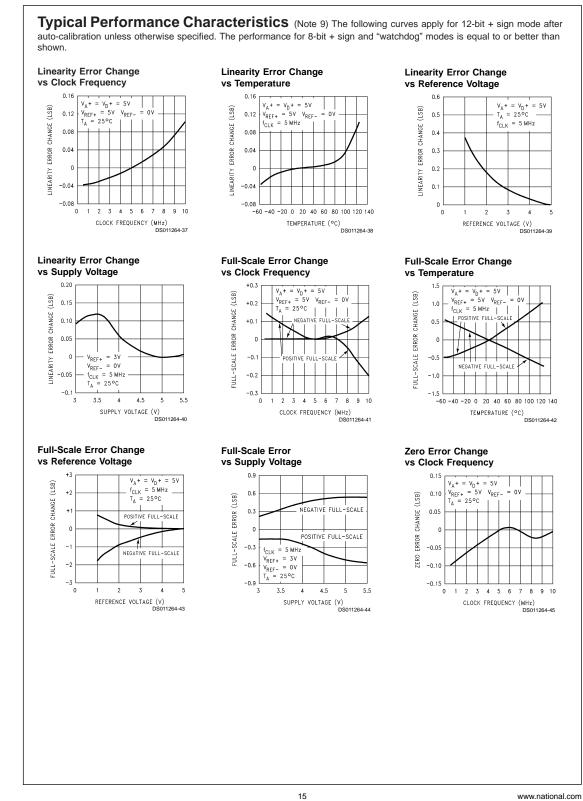


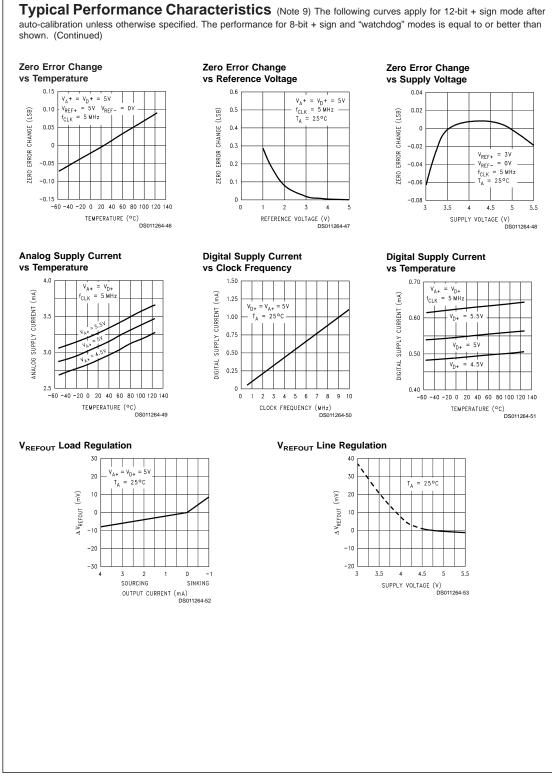


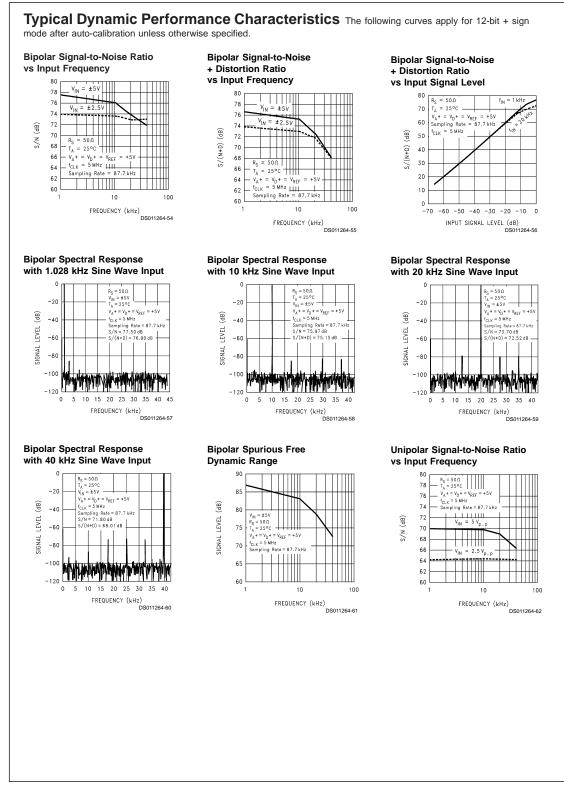


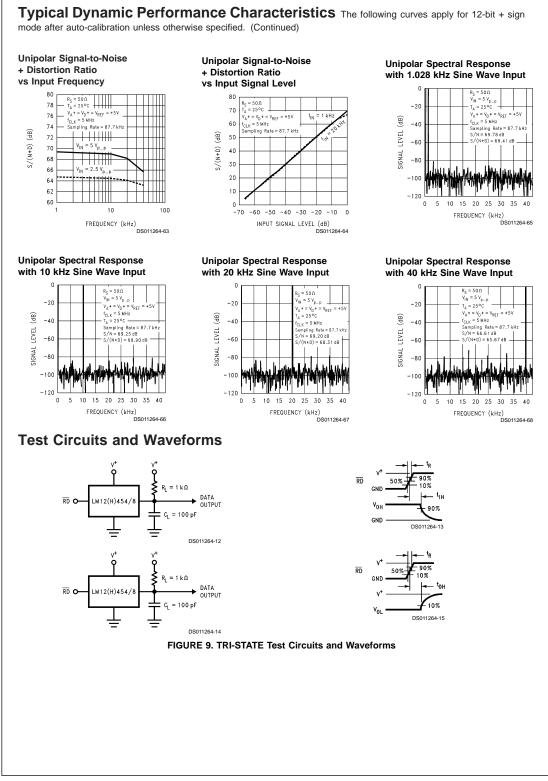


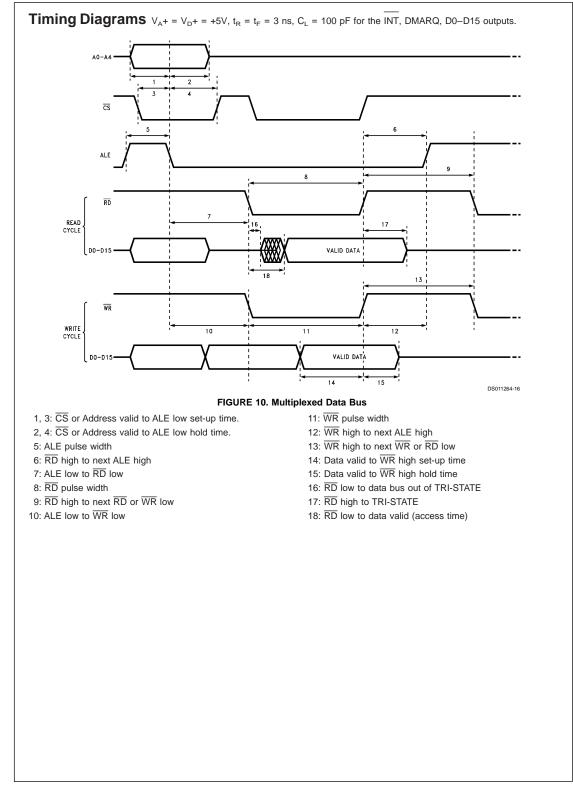


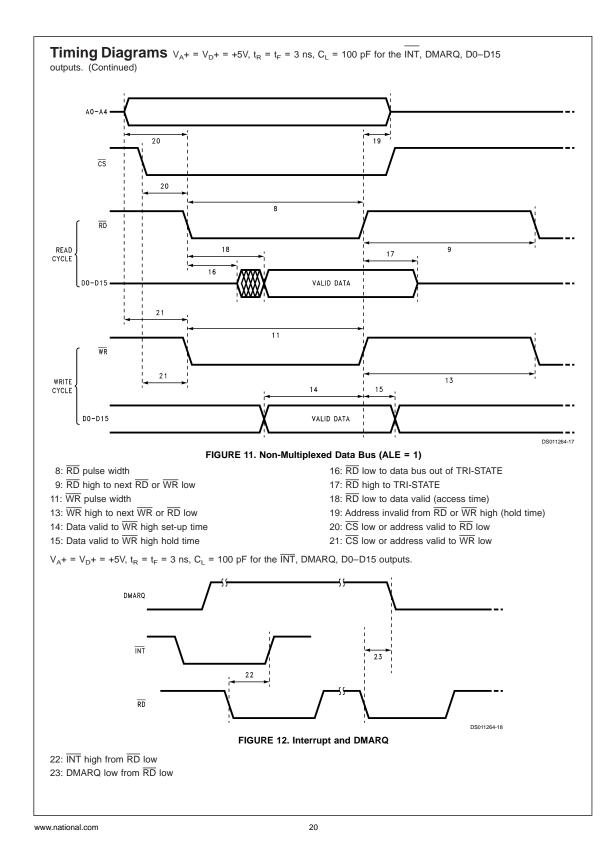












# **Pin Description**

- $V_{\text{A}}\text{+}V_{\text{D}}\text{+}$  Analog and digital supply voltage pins. The LM12(H)454/8's supply voltage operating range is +3.0V to +5.5V. Accuracy is guaranteed only if  $V_{\text{A}}\text{+}$  and  $V_{\text{D}}\text{+}$  are connected to the same power supply. Each pin should have a parallel combination of 10  $\mu\text{F}$  (electrolytic or tantalum) and 0.1  $\mu\text{F}$  (ceramic) bypass capacitors connected between it and ground.
- D0–D15 The internal data input/output TRI-STATE buffers are connected to these pins. These buffers are designed to drive capacitive loads of 100 pF or less. External buffers are necessary for driving higher load capacitances. These pins allows the user a means of instruction input and data output. With a logic **high** applied to the **BW** pin, data lines D8–D15 are placed in a high impedance state and data lines D0–D7 are used for instruction input and data output when the LM12(H)454/8 is connected to an 8-bit wide data bus. A logic **low** on the **BW** pin allows the LM12(H)454/8 to exchange information over a 16-bit wide data bus.
- RD Input for the active low READ bus control signal. The data input/output TRI-STATE buffers, as selected by the logic signal applied to the **BW** pin, are enabled when RD and CS are both low. This allows the LM12(H)454/8 to transmit information onto the databus.
- WR Input for the active low WRITE bus control signal. The data input/output TRI-STATE buffers, as selected by the logic signal applied to the **BW** pin, are enabled when WR and CS are both low. This allows the LM12(H)454/8 to receive information from the databus.
- CS Input for the active low Chip Select control signal. A logic low should be applied to this pin only during a READ or WRITE access to the LM12(H)454/8. The internal clocking is halted and conversion stops while Chip Select is low. Conversion resumes when the Chip Select input signal returns high.
- ALE Address Latch Enable input. It is used in systems containing a multiplexed databus. When ALE is asserted **high**, the LM12(H)454/8 accepts information on the databus as a valid address. A high-to-low transition will latch the address data on A0–A4 while the CS is low. Any changes on A0–A4 and CS while ALE is low will not affect the LM12(H)454/8. See *Figure 10*. When a non-multiplexed bus is used, ALE is continuously asserted **high**. See *Figure 11*.
- CLK External clock input pin. The LM12(H)454/8 operates with an input clock frequency in the range of 0.05 MHz to 10.0 MHz.
- A0–A4 The LM12(H)454/8's address lines. They are used to access all internal registers, Conversion FIFO, and Instruction **RAM**.
- SYNC Synchronization input/output. When used as an output, it is designed to drive capacitive loads of 100 pF or less. External buffers are necessary for driving higher load capacitances. SYNC is an input if the Configuration register's "I/O Select" bit is low. A rising edge on this pin causes the inter-

nal S/H to hold the input signal. The next rising clock edge either starts a conversion or makes a comparison to a programmable limit depending on which function is requested by a programming instruction. This pin will be an **output** if "I/O Select" is set **high**. The SYNC output goes high when a conversion or a comparison is started and low when completed. (See Section 2.2). An internal reset after power is first applied to the LM12(H)454/8 automatically sets this pin as an input.

- BW Bus Width input pin. This input allows the LM12(H)454/8 to interface directly with either an 8- or 16-bit databus. A logic high sets the width to 8 bits and places D8–D15 in a high impedance state. A logic low sets the width to 16 bits.
- INT Active low interrupt output. This output is designed to drive capacitive loads of 100 pF or less. External buffers are necessary for driving higher load capacitances. An interrupt signal is generated any time a non-masked interrupt condition takes place. There are eight different conditions that can cause an interrupt. Any interrupt is reset by reading the Interrupt Status register. (See Section 2.3.)
- DMARQ Active high Direct Memory Access Request output. This output is designed to drive capacitive loads of 100 pF or less. External buffers are necessary for driving higher load capacitances. It goes high whenever the number of conversion results in the conversion FIFO equals a programmable value stored in the Interrupt Enable register. It returns to a logic low when the FIFO is empty.
- GND LM12(H)454/8 ground connection. It should be connected to a low resistance and inductance analog ground return that connects directly to the system power supply ground.
- IN0-IN7The eight (LM12(H)458) or four (LM12454)(IN0-IN3analog inputs. A given channel is selectedLM12H454through the instruction RAM. Any of the chan-
- LM12454) nels can be configured as an independent single-ended input. Any pair of channels, whether adjacent or non-adjacent, can operate as a fully differential pair.
- S/H IN+ The LM12454's non-inverting and inverting in-S/H IN- puts to the internal S/H.
- MUXOUT+ The LM12454's non-inverting and inverting out-
- MUXOUT- puts from the internal multiplexer.
- $V_{\text{REF+}}$  The positive reference input. The LM12(H)454/8 operate with 0V  $\leq V_{\text{REF+}} \leq V_{\text{A}}$ +. This pin should be bypassed to ground with a parallel combination of 10  $\mu\text{F}$  and 0.1  $\mu\text{F}$  (ceramic) capacitors.
- $V_{\text{REFOUT}}$  The internal 2.5V bandgap's output pin. This pin should be bypassed to ground with a 100  $\mu$ F capacitor.

# **Application Information**

# **1.0 Functional Description**

The LM12454 and LM12(H)458 are multi-functional Data Acquisition Systems that include a fully differential 12-bit-plus-sign self-calibrating analog-to-digital converter (ADC) with a two's-complement output format, an 8-channel (LM12(H)458) or a 4-channel (LM12454) analog multiplexer, an internal 2.5V reference, a first-in-first-out (FIFO) register that can store 32 conversion results, and an Instruction RAM that can store as many as eight instructions to be sequentially executed. The LM12454 also has a differential multiplexer output and a differential S/H input. All of this circuitry operates on only a single +5V power supply.

The LM12(H)454/8 have three modes of operation:

12-bit + sign with correction

8-bit + sign without correction

8-bit + sign comparison mode ("watchdog" mode)

The fully differential 12-bit-plus-sign ADC uses a charge redistribution topology that includes calibration capabilities. Charge re-distribution ADCs use a capacitor ladder in place of a resistor ladder to form an internal DAC. The DAC is used by a successive approximation register to generate intermediate voltages between the voltages applied to V<sub>REF+</sub>. These intermediate voltages are compared against the sampled analog input voltage as each bit is generated. The number of intermediate voltages and comparisons equals the ADC's resolution. The correction of each bit's accuracy is accomplished by calibrating the capacitor ladder used in the ADC.

Two different calibration modes are available; one compensates for offset voltage, or zero error, while the other corrects both offset error and the ADC's linearity error.

When correcting offset only, the offset error is measured once and a correction coefficient is created. During the full calibration, the offset error is measured eight times, averaged, and a correction coefficient is created. After completion of either calibration mode, the offset correction coefficient is stored in an internal offset correction register.

The LM12(H)454/8's overall linearity correction is achieved by correcting the internal DAC's capacitor mismatch. Each capacitor is compared eight times against all remaining smaller value capacitors and any errors are averaged. A correction coefficient is then created and stored in one of the thirteen internal linearity correction registers. An internal state machine, using patterns stored in an internal 16 x 8-bit ROM, executes each calibration algorithm.

Once calibrated, an internal arithmetic logic unit (ALU) uses the offset correction coefficient and the 13 linearity correction coefficients to reduce the conversion's offset error and linearity error, in the background, during the 12-bit + sign conversion. The 8-bit + sign conversion and comparison modes use only the offset coefficient. The 8-bit + sign mode performs a conversion in less than half the time used by the 12-bit + sign conversion mode.

The LM12(H)454/8's "watchdog" mode is used to monitor a single-ended or differential signal's amplitude. Each sampled signal has two limits. An interrupt can be generated if the input signal is above or below either of the two limits. This allows interrupts to be generated when analog voltage inputs are "inside the window" or, alternatively, "outside the window". After a "watchdog" mode interrupt, the processor can then request a conversion on the input signal and read the signal's magnitude.

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The analog input multiplexer can be configured for any combination of single-ended or fully differential operation. Each input is referenced to ground when a multiplexer channel operates in the single-ended mode. Fully differential analog input channels are formed by pairing any two channels together.

The LM12454's multiplexer outputs and S/H inputs (MUX-OUT+, MUXOUT– and S/H IN+, S/H IN–) provide the option for additional analog signal processing. Fixed-gain amplifiers, programmable-gain amplifiers, filters, and other processing circuits can operate on the signal applied to the selected multiplexer channel(s). If external processing is not used, connect MUXOUT+ to S/H IN+ and MUXOUT– to S/H IN–.

The LM12(H)454/8's internal S/H is designed to operate at its minimum acquisition time (1.13  $\mu$ s, 12 bits) when the source impedance,  $R_{\rm S},$  is  $\leq 60\Omega$  ( $f_{\rm CLK} \leq 8$  MHz). When  $60\Omega$   $< R_{\rm S} \leq 4.17$  kΩ, the internal S/H's acquisition time can be increased to a maximum of 4.88  $\mu$ s (12 bits,  $f_{\rm CLK}$  = 8 MHz). See Section 2.1 (Instruction RAM "00") Bits 12–15 for more information.

An internal 2.5V bandgap reference output is available at pin 44. This voltage can be used as the ADC reference for ratiometric conversion or as a virtual ground for front-end analog conditioning circuits. The  $V_{\mathsf{REFOUT}}$  pin should be bypassed to ground with a 100  $\mu$ F capacitor.

Microprocessor overhead is reduced through the use of the internal conversion FIFO. Thirty-two consecutive conversions can be completed and stored in the FIFO without any microprocessor intervention. The microprocessor can, at any time, interrogate the FIFO and retrieve its contents. It can also wait for the LM12(H)454/8 to issue an interrupt when the FIFO is full or after any number ( $\leq$ 32) of conversions have been stored.

Conversion sequencing, internal timer interval, multiplexer configuration, and many other operations are programmed and set in the Instruction RAM.

A diagnostic mode is available that allows verification of the LM12(H)458's operation. The diagnostic mode is disabled in the LM12454. This mode internally connects the voltages present at the V<sub>REFOUT</sub>, V<sub>REF+</sub>, V<sub>REF-</sub>, and GND pins to the internal V<sub>IN+</sub> and V<sub>IN-</sub> S/H inputs. This mode is activated by setting the Diagnostic bit (Bit 11) in the Configuration register to a "1". More information concerning this mode of operation can be found in Section 2.2.

# 2.0 Internal User-Programmable Registers

## INSTRUCTION RAM

The instruction RAM holds up to eight sequentially executable instructions. Each 48-bit long instruction is divided into three 16-bit sections. READ and WRITE operations can be issued to each 16-bit section using the instruction's address and the 2-bit "RAM pointer" in the Configuration register. The eight instructions are located at addresses 0000 through 0111 (A4–A1, BW = 0) when using a 16-bit wide data bus or at addresses 00000 through 01111 (A4–A0, BW = 1) when using an 8-bit wide data bus. They can be accessed and programmed in random order.

# 2.0 Internal User-Programmable Registers (Continued)

Any Instruction RAM READ or WRITE can affect the sequencer's operation:

The Sequencer should be stopped by setting the RESET bit to a "1" or by resetting the START bit in the Configuration Register and waiting for the current instruction to finish execution before any Instruction RAM READ or WRITE is initiated.

A soft RESET should be issued by writing a "1" to the Configuration Register's RESET bit after any READ or WRITE to the Instruction RAM.

The three sections in the Instruction RAM are selected by the Configuration Register's 2-bit "RAM Pointer", bits D8 and D9. The first 16-bit Instruction RAM section is selected with the RAM Pointer equal to "00". This section provides multiplexer channel selection, as well as resolution, acquisition time, etc. The second 16-bit section holds "watchdog" limit #1, its sign, and an indicator that shows that an interrupt can be generated if the input signal is greater or less than the programmed limit. The third 16-bit section holds "watchdog" limit #2, its sign, and an indicator that shows that an interrupt can be generated if the input signal is greater or less than the programmed limit.

#### Instruction RAM "00"

**Bit 0** is the LOOP bit. It indicates the last instruction to be executed in any instruction sequence when it is set to a "1". The next instruction to be executed will be instruction 0.

**Bit 1** is the PAUSE bit. This controls the Sequencer's operation. When the PAUSE bit is set ("1"), the Sequencer will stop after reading the current instruction and before executing it, and the start bit in the Configuration register is automatically reset to a "0". Setting the PAUSE also causes an interrupt to be issued. The Sequencer is restarted by placing a "1" in the Configuration register's Bit 0 (Start bit).

After the Instruction RAM has been programmed and the RESET bit is set to "1", the Sequencer retrieves Instruction 000, decodes it, and waits for a "1" to be placed in the Configuration's START bit. The START bit value of "0" "overrides" the action of Instruction 000's PAUSE bit when the Sequencer is started. Once started, the Sequencer executes Instruction 000 and retrieves, decodes, and executes each of the remaining instructions. No PAUSE Interrupt (INT 5) is generated the first time the Sequencer executes Instruction 000 having a PAUSE bit set to "1". When the Sequencer encounters a LOOP bit or completes all eight instructions, Instruction 000 is retrieved and decoded. A set PAUSE bit in Instruction 000 now halts the Sequencer before the instruction is executed.

**Bits 2–4** select which of the eight input channels ("000" to "111" for IN0–IN7) will be configured as non-inverting inputs to the LM12(H)458's ADC. (See Page 27, *Table 1.*) They select which of the four input channels ("000" to "011" for IN0–IN4) will be configured as non-inverting inputs to the LM12454's ADC. (See Page 27, *Table 2.*)

Bits 5–7 select which of the seven input channels ("001" to "111" for IN1 to IN7) will be configured as inverting inputs to the LM12(H)458's ADC. (See Page 27, *Table 1.*) They select which of the three input channels ("001" to "011" for IN1–IN4) will be configured as inverting inputs to the LM12454's ADC. (See Page 27, *Table 2.*) Fully differential operation is created by selecting two multiplexer channels, one operating in the non-inverting mode and the other operating in the inverting mode. A code of "000" selects ground as the inverting input for single ended operation.

**Bit 8** is the SYNC bit. Setting Bit 8 to "1" causes the Sequencer to suspend operation at the end of the internal S/H's acquisition cycle and to wait until a rising edge appears at the SYNC pin. When a rising edge appears, the S/H acquires the input signal magnitude and the ADC performs a conversion on the clock's next rising edge. When the SYNC pin is used as an input, the Configuration register's "I/O Select" bit (Bit 7) must be set to a "0". With SYNC configured as an input, it is possible to synchronize the start of a conversion to an external event. This is useful in applications such as digital signal processing (DSP) where the exact timing of conversions is important.

When the LM12(H)454/8 are used in the "watchdog" mode with external synchronization, two rising edges on the SYNC input are required to initiate two comparisons. The first rising edge initiates the comparison of the selected analog input signal with Limit #1 (found in Instruction RAM "01") and the second rising edge initiates the comparison of the same analog input signal with Limit #2 (found in Instruction RAM "10").

**Bit 9** is the TIMER bit. When Bit 9 is set to "1", the Sequencer will halt until the internal 16-bit Timer counts down to zero. During this time interval, no "watchdog" comparisons or analog-to-digital conversions will be performed.

**Bit 10** selects the ADC conversion resolution. Setting Bit 10 to "1" selects 8-bit + sign and when reset to "0" selects 12-bit + sign.

**Bit 11** is the "watchdog" comparison mode enable bit. When operating in the "watchdog" comparison mode, the selected analog input signal is compared with the programmable values stored in Limit #1 and Limit #2 (see Instruction RAM "01" and Instruction RAM "10"). Setting Bit 11 to "1" causes two comparisons of the selected analog input signal with the two stored limits. When Bit 11 is reset to "0", an 8-bit + sign or 12-bit + sign (depending on the state of Bit 10 of Instruction RAM "00") conversion of the input signal can take place.

0 0 0 Instru to (RAM I 1 1 1																
-	Instruction KAM	КV	Acquisition	>	Watch-					VIN-			< <sup>N+</sup>			
1 1	(RAM Pointer = 00)		Time		gob	8/12	8/12 Timer Sync	Sync	(ML	(MUXOUT-)	-	(ML	(MUXOUT+)		Pause Loop	Loo
									Z)	(Note 20)		Ę	(Note 20)	_		
0 0 0 Instru	Instruction RAM	R/N														
to (RAM I	(RAM Pointer = 01)		Ō	Don't Care	e		⊻ ^	Sign				Limit #1	#1			
1 1																
0 0 0 Instru	Instruction RAM	R/W														
to (RAM I	(RAM Pointer = 10)		Ō	Don't Care	e		<u>∨</u> ^	Sign				Limit #2	#2			
1 1																
0 0 0 Cor	Configuration	R/V	Don't Care		DIAG	Test	RAM	z	õ	Auto Chan Stand- Full	Chan S	stand-	Full	Auto-	Auto- Reset Start	Stai
Ľ	Register			Z	(Note 21)	0 =	Pointer		Sel	Zero <sub>ec</sub>	Mask	by	CAL	Zero		
Interr	Interrupt Enable	R/W	Number of Conversions	Convers	sions	s	Sequencer		INT7	INT6	INT5	INT4	INT3	INT2	INT1	INT0
0 0 1 F	Register		in Conversion FIFO	rsion FIF	0	Ad	Address to	0								
			to Generate INT2	erate INT	2	Gen	Generate INT1	LT1								
						◄	Address									
		۲	Actual N	Actual Number of	of		of	<u> </u>	VST7	NST6	NST5	NST4	NST3	NST2	INST7 INST6 INST5 INST4 INST3 INST2 INST1 INST0	INST
0 1 0 Inter	Interrupt Status		Conversion Results	on Resu	lts	s	Sequencer	E.								
Ľ	Register		in Conversion FIFO	rsion FIF	0	Ë	Instruction	c								
							being									
						ш	Executed	77								
0 1 1	Timer	R/W	F	imer Pre	Timer Preset High Byte	Byte					Time	Timer Preset Low Byte	t Low E	syte		
Ľ	Register															
1 0 0 Co	Conversion	ĸ	Address S	Sign	Cor	Conversion	u				Conve	Conversion Data: LSBs	Data: L	SBs		
	FIFO		or Sign		Dati	Data: MSBs	ß									
1 0 1 Lin	Limit Status	ъ		Limit 3	Limit #2: Status							Limit #1: Status	Status			
Ľ	Register															

# 2.0 Internal User-Programmable Registers (Continued)

A4	A3	A2	A1	A0	Purpose	Туре	D7	D6	D5	D4	D3	D2	D1	D0
	0	0	0			R/W		V <sub>IN-</sub> JXOUT-) (No			V <sub>IN+</sub> OUT+) (Not			
0		to		0	Instruction		(MU	JXOUI-) (No	te 22)	(MUX)	OUI+) (Not	e 22)	Pause	Loop
	1	1	1		RAM (RAM									
	0	0	0		Pointer =	R/W					Watch-			
0		to		1	00)			Acquisit	on Time		dog	8/12	Timer	Sync
	1	1	1											
	0	0	0			R/W								
0		to		0	Instruction				(	Comparison	Limit #1			
	1	1	1		RAM (RAM	<b>D</b> 444								
0	0	0	0	1	Pointer = 01)	R/W			Don't	Care			~/~	Cian
0	1	to 1	1	1	- /				Don't	Care			>/<	Sign
	0	0	0			R/W								
0	0	to	0	0		10/00			(	Comparison	Limit #2			
0	1	1	1	0	Instruction RAM				· · ·	2011120113011				
	0	0	0		(RAM Pointer =	R/W								
0	0	to	0	1	10)				Don't	Care			>/<	Sign
-	1	1	1	-										
1	0	0	0	0		R/W	I/O	Auto	Chan	Stand-	Full	Auto-	Reset	Start
					Configuration		Sel	Zero <sub>ec</sub>	Mask	by	Cal	Zero		
1	0	0	0	1	Register	R/W		Don't Care DIAG (Note 0			RAM I	Pointer		
1	0	0	1	0		R/W	INT7	INT6	INT5	INT4	23) INT3	INT2	INT1	INT0
1	0	0	1	0	Interrupt	10/00			INTS	11114	11113	INTZ		
1	0	0	1	1	Enable Register	R/W		Number of C	onversions i	n Conversio	<u> </u>	Seque	encer Addr	ess to
-	-	-	-	-	register				to Generate				enerate IN	
1	0	1	0	0		R	INST7	INST6	INST5	INST4	INST3	INST2	INST1	INST0
					Internut									
1	0	1	0	1	Interrupt Status	R		Actual Numbe	er of Conve	sions Resu	lts	Addre	ss of Sequ	lencer
					Register			in C	onversion F	IFO			Instruction	
												be	ing Execut	ed
1	0	1	1	0	Timer	R/W			Ti	mer Preset:	Low Byte			
1	0	1	1	1	Register	R/W			Ti	mer Preset:	High Byte			
1	1	0	0	0	Conversion	R			C	onversion D	ata: LSBs			
1	1	0	0	1	FIFO	R		Address or Si	gn	Sign	C	onversion [	Data: MSB	s
1	1	0	1	0	Limit Status	R				Limit #1 \$	Status			

# FIGURE 14. LM12(H)454/8 Memory Map for 8-Bit Wide Databus (BW = "1" and Test Bit = "0")

Note 22: LM12454 (Refer to Table 2).

Note 23: LM12(H)458 only. Must be set to "0" for the LM12454.

# 2.0 Internal User-Programmable Registers (Continued)

Bits 12-15 are used to store the user-programmable acquisition time. The Sequencer keeps the internal S/H in the acquisition mode for a fixed number of clock cycles (nine clock cycles, for 12-bit + sign conversions and two clock cycles for 8-bit + sign conversions or "watchdog" comparisons) plus a variable number of clock cycles equal to twice the value stored in Bits 12-15. Thus, the S/H's acquisition time is (9 + 2D) clock cycles for 12-bit + sign conversions and (2 + 2D) clock cycles for 8-bit + sign conversions or "watchdog" comparisons, where D is the value stored in Bits 12-15. The minimum acquisition time compensates for the typical internal multiplexer series resistance of 2 kΩ, and any additional delay created by Bits 12-15 compensates for source resistances greater than  $60\Omega$  ( $100\Omega$ ). (For this acquisition time discussion, numbers in ( ) are shown for the LM12(H)454/8 operating at 5 MHz.) The necessary acquisition time is determined by the source impedance at the multiplexer input. If the source resistance (R\_s) < 60  $\Omega$  (100  $\Omega$ ) and the clock frequency is 8 MHz, the value stored in bits 12-15 (D) can be 0000. If  $R_S > 60\Omega$  (100 $\Omega$ ), the following equations determine the value that should be stored in bits 12-15.

for 12-bits + sign

$$D = 0.36 \times R_S \times f_{CLR}$$

for 8-bits + sign and "watchdog"

 $R_{S}$  is in  $k\Omega$  and  $f_{{\rm CLK}}$  is in MHz. Round the result to the next higher integer value. If D is greater than 15, it is advisable to lower the source impedance by using an analog buffer between the signal source and the LM12(H)458's multiplexer inputs. The value of D can also be used to compensate for the settling or response time of external processing circuits connected between the LM12454's MUXOUT and S/H IN pins.

#### Instruction RAM "01"

The second Instruction RAM section is selected by placing a "01" in Bits 8 and 9 of the Configuration register.

Bits 0–7 hold "watchdog" limit #1. When Bit 11 of Instruction RAM "00" is set to a "1", the LM12(H)454/8 performs a "watchdog" comparison of the sampled analog input signal with the limit #1 value first, followed by a comparison of the same sampled analog input signal with the value found in limit #2 (Instruction RAM "10").

Bit 8 holds limit #1's sign.

**Bit 9**'s state determines the limit condition that generates a "watchdog" interrupt. A "1" causes a voltage greater than limit #1 to generate an interrupt, while a "0" causes a voltage less than limit #1 to generate an interrupt.

Bits 10-15 are not used.

#### Instruction RAM "10"

The third Instruction RAM section is selected by placing a "10" in Bits 8 and 9 of the Configuration register.

**Bits 0–7** hold "watchdog" **limit #2**. When Bit 11 of Instruction RAM "00" is set to a "1", the LM12(H)454/8 performs a "watchdog" comparison of the sampled analog input signal with the limit #1 value first (Instruction RAM "01"), followed by a comparison of the same sampled analog input signal with the value found in limit #2.

Bit 8 holds limit #2's sign.

**Bit 9** 's state determines the limit condition that generates a "watchdog" interrupt. A "1" causes a voltage greater than limit #2 to generate an interrupt, while a "0" causes a voltage less than limit #2 to generate an interrupt. **Bits 10–15** are not used.

#### 2.2 CONFIGURATION REGISTER

The Configuration register, 1000 (A4–A1, BW = 0) or 1000x (A4–A0, BW = 1) is a 16-bit control register with read/write capability. It acts as the LM12454's and LM12(H)458's "control panel" holding global information as well as start/stop, reset, self-calibration, and stand-by commands.

**Bit 0** is the START/STOP bit. Reading Bit 0 returns an indication of the Sequencer's status. A "0" indicates that the Sequencer is stopped and waiting to execute the next instruction. A "4" shows that the Sequencer is running. Writing a "0" halts the Sequencer when the current instruction has finished execution. The next instruction to be executed is pointed to by the instruction pointer found in the status register. A "1" restarts the Sequencer with the instruction currently pointed to by the instruction pointer. (See Bits 8–10 in the Interrupt Status register.)

**Bit 1** is the LM12(H)454/8's system RESET bit. Writing a "1" to Bit 1 stops the Sequencer (resetting the Configuration register's START/STOP bit), resets the Instruction pointer to "000" (found in the Interrupt Status register), clears the Conversion FIFO, and resets all interrupt flags. The RESET bit will return to "0" after two clock cycles unless it is forced high by writing a "1" into the Configuration register's Standby bit. A reset signal is internally generated when power is first applied to the part. No operation should be started until the RESET bit is "0".

Writing a "1" to Bit 2 initiates an auto-zero offset voltage calibration. Unlike the eight-sample auto-zero calibration performed during the full calibration procedure, Bit 2 initiates a "short" auto-zero by sampling the offset once and creating a correction coefficient (full calibration averages eight samples of the converter offset voltage when creating a correction coefficient). If the Sequencer is running when Bit 2 is set to "1", an auto-zero starts immediately after the conclusion of the currently running instruction. Bit 2 is reset automatically to a "0" and an interrupt flag (Bit 3, in the Interrupt Status register) is set at the end of the auto-zero (76 clock cycles). After completion of an auto-zero calibration, the Sequencer fetches the next instruction as pointed to by the Instruction RAM's pointer and resumes execution. If the Sequencer is stopped, an auto-zero is performed immediately at the time requested.

Writing a "1" to **Bit 3** initiates a complete calibration process that includes a "long" auto-zero offset voltage correction (this calibration averages eight samples of the comparator offset voltage when creating a correction coefficient) followed by an ADC linearity calibration. This complete calibration is started after the currently running instruction is completed if the Sequencer is running when Bit 3 is set to "1". Bit 3 is reset automatically to a "0" and an interrupt flag (Bit 4, in the Interrupt Status register) will be generated at the end of the calibration procedure (4944 clock cycles). After completion of a full auto-zero and linearity calibration, the Sequencer fetches the next instruction as pointed to by the Instruction RAM's pointer and resumes execution. If the Sequencer is stopped, a full calibration is performed immediately at the time requested.

**Bit 4** is the Standby bit. Writing a "1" to Bit 4 immediately places the LM12(H)454/8 in Standby mode. Normal operation returns when Bit 4 is reset to a "0". The Standby com-

# 2.0 Internal User-Programmable Registers (Continued)

mand ("1") disconnects the external clock from the internal circuitry, decreases the LM12(H)454/8's internal analog circuitry power supply current, and preserves all internal RAM contents. After writing a "0" to the Standby bit, the LM12(H)454/8 returns to an operating state identical to that caused by exercising the RESET bit. A Standby completion interrupt is issued after a power-up completion delay that allows the analog circuitry to settle. The Sequencer should be restarted only after the Standby completion is issued. The Instruction RAM can still be accessed through read and write operations while the LM12(H)454/8 are in Standby Mode.

**Bit 5** is the Channel Address Mask. If Bit 5 is set to a "1", Bits 13–15 in the conversion FIFO will be equal to the sign bit (Bit 12) of the conversion data. Resetting Bit 5 to a "0" causes conversion data Bits 13 through 15 to hold the instruction pointer value of the instruction to which the conversion data belongs.

**Bit 6** is used to select a "short" auto-zero correction for every conversion. The Sequencer automatically inserts an auto-zero before every conversion or "watchdog" comparison if Bit 6 is set to "1". No automatic correction will be performed if Bit 6 is reset to "0".

The LM12(H)454/8's offset voltage, after calibration, has a typical drift of 0.1 LSB over a temperature range of -40°C to +85°C. This small drift is less than the variability of the change in offset that can occur when using the auto-zero correction with each conversion. This variability is the result of using only one sample of the offset voltage to create a correction value. This variability decreases when using the full calibration mode because eight samples of the offset voltage are taken, averaged, and used to create a correction value. Bit 7 is used to program the SYNC pin (29) to operate as either an input or an output. The SYNC pin becomes an output when Bit 7 is a "1" and an input when Bit 7 is a "0". With SYNC programmed as an input, the rising edge of any logic signal applied to pin 29 will start a conversion or "watchdog" comparison. Programmed as an output, the logic level at pin 29 will go high at the start of a conversion or "watchdog" comparison and remain high until either have finished. See

Instruction RAM "00", Bit 8. Bits 8 and 9 form the RAM Pointer that is used to select each of a 48-bit instruction's three 16-bit sections during read or write actions. A "00" selects Instruction RAM section one, "01" selects section two, and "10" selects section three. Bit 10 activates the Test mode that is used only during production testing. Leave this bit reset to "0".

Bit 11 is the Diagnostic bit and is available only in the LM12(H)458. It can be activated by setting it to a "1" (the Test bit must be reset to a "0"). The Diagnostic mode, along with a correctly chosen instruction, allows verification that the LM12(H)458's ADC is performing correctly. When activated, the inverting and non-inverting inputs are connected as shown in Table I. As an example, an instruction with "001" for both V<sub>IN+</sub> and V<sub>IN-</sub> while using the Diagnostic mode typically results in a full-scale output.

#### 2.3 INTERRUPTS

The LM12454 and LM12(H)458 have eight possible interrupts, all with the same priority. Any of these interrupts will cause a hardware interrupt to appear on the  $\overline{\text{INT}}$  pin (31) if they are not masked (by the Interrupt Enable register). The Interrupt Status register is then read to determine which of the eight interrupts has been issued.

#### TABLE 1. LM12(H)458 Input Multiplexer Channel Configuration Showing Normal Mode and Diagnostic Mode

Channel Selection		mal ode	Diagn Mo	
Data	V <sub>IN+</sub>	V <sub>IN-</sub>	V <sub>IN+</sub>	V <sub>IN-</sub>
000	IN0	GND	V <sub>REFOUT</sub>	GND
001	IN1	IN1	V <sub>REF+</sub>	V <sub>REF-</sub>
010	IN2	IN2	IN2	IN2
011	IN3	IN3	IN3	IN3
100	IN4	IN4	IN4	IN4
101	IN5	IN5	IN5	IN5
110	IN6	IN6	IN6	IN6
111	IN7	IN7	IN7	IN7

#### TABLE 2. LM12454 Input Multiplexer Channel Configuration

Channel Selection Data	MUX+	MUX-
000	IN0	GND
001	IN1	IN1
010	IN2	IN2
011	IN3	IN3
1XX	OPEN	OPEN

The Interrupt Status register, 1010 (A4–A1, BW = 0) or 1010x (A4–A0, BW = 1) must be cleared by reading it after writing to the Interrupt Enable register. This removes any spurious interrupts on the  $\overline{\rm INT}$  pin generated during an Interrupt Enable register access.

**Interrupt 0** is generated whenever the analog input voltage on a selected multiplexer channel crosses a limit while the LM12(H)454/8 are operating in the "watchdog" comparison mode. Two sequential comparisons are made when the LM12(H)454/8 are executing a "watchdog" instruction. Depending on the logic state of Bit 9 in the Instruction RAM's second and third sections, an interrupt will be generated either when the input signal's magnitude is greater than or less than the programmable limits. (See the Instruction RAM, Bit 9 description.) The Limit Status register will indicate which preprogrammed limit, #1 or #2 and which instruction was executing when the limit was crossed.

**Interrupt 1** is generated when the Sequencer reaches the instruction counter value specified in the Interrupt Enable register's bits 8–10. This flag appears before the instruction's execution.

**Interrupt 2** is activated when the Conversion FIFO holds a number of conversions equal to the programmable value stored in the Interrupt Enable register's Bits 11–15. This value ranges from 0001 to 1111, representing 1 to 31 conversions stored in the FIFO. A user-programmed value of 0000 has no meaning. See Section 3.0 for more FIFO information.

The completion of the short, single-sampled auto-zero calibration generates **Interrupt 3**.

# 2.0 Internal User-Programmable Registers (Continued)

The completion of a full auto-zero and linearity self-calibration generates  $Interrupt \ 4.$ 

**Interrupt 5** is generated when the Sequencer encounters an instruction that has its Pause bit (Bit 1 in Instruction RAM "00") set to "1".

The LM12(H)454/8 issues **Interrupt 6** whenever it senses that its power supply voltage is dropping below 4V (typ). This interrupt indicates the potential corruption of data returned by the LM12(H)454/8.

**Interrupt 7** is issued after a short delay (10 ms typ) while the LM12(H)454/8 returns from Standby mode to active operation using the Configuration register's Bit 4. This short delay allows the internal analog circuitry to settle sufficiently, ensuring accurate conversion results.

#### 2.4 INTERRUPT ENABLE REGISTER

The Interrupt Enable register at address location 1001 (A4–A1, BW = 0) or 1001x (A4–A0, BW = 1) has READ/ WRITE capability. An individual interrupt's ability to produce an external interrupt at pin 31 ( $\overline{INT}$ ) is accomplished by placing a "1" in the appropriate bit location. Any of the internal interrupt-producing operations will set their corresponding bits to "1" in the Interrupt Status register regardless of the state of the associated bit in the Interrupt Enable register. See Section 2.3 for more information about each of the eight interrupts.

**Bit 0** enables an external interrupt when an internal "watchdog" comparison limit interrupt has taken place.

**Bit 1** enables an external interrupt when the Sequencer has reached the address stored in Bits 8–10 of the Interrupt Enable register.

**Bit 2** enables an external interrupt when the Conversion FIFO's limit, stored in Bits 11–15 of the Interrupt Enable register, has been reached.

**Bit 3** enables an external interrupt when the single-sampled auto-zero calibration has been completed.

**Bit 4** enables an external interrupt when a full auto-zero and linearity self-calibration has been completed.

**Bit 5** enables an external interrupt when an internal Pause interrupt has been generated.

**Bit 6** enables an external interrupt when a low power supply condition ( $V_A$ + < 4V) has generated an internal interrupt.

**Bit 7** enables an external interrupt when the LM12(H)454/8 return from power-down to active mode.

Bits 8–10 form the storage location of the user-programmable value against which the Sequencer's address is compared. When the Sequencer reaches an address that is equal to the value stored in Bits 8–10, an internal interrupt is generated and appears in Bit 1 of the Interrupt Status register. If Bit 1 of the Interrupt Enable register is set to "1", an external interrupt will appear at pin 31 (INT).

The value stored in bits 8–10 ranges from 000 to 111, representing 0 to 7 instructions stored in the Instruction RAM. After the Instruction RAM has been programmed and the RE-SET bit is set to "1", the Sequencer is started by placing a "1" in the Configuration register's START bit. Setting the INT 1 trigger value to 000 **does not generate** an INT 1 the **first** time the Sequencer retrieves and decodes Instruction 000. The Sequencer **generates** INT 1 (by placing a "1" in the Interrupt Status register's Bit 1) the **second time and after** the Sequencer encounters Instruction 000. It is important to re-

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member that the Sequencer continues to operate even if an Instruction interrupt (INT 1) is internally or externally generated. The only mechanisms that stop the Sequencer are an instruction with the PAUSE bit set to "1" (halts before instruction execution), placing a "0" in the Configuration register's START bit, or placing a "1" in the Configuration register's RE-SET bit.

**Bits 11–15** hold the number of conversions that must be stored in the Conversion FIFO in order to generate an internal interrupt. This internal interrupt appears in Bit 2 of the Interrupt Status register. If Bit 2 of the Interrupt Enable register is set to "1", an external interrupt will appear at pin 31 (INT).

#### 2.5 INTERRUPT STATUS REGISTER

This read-only register is located at address 1010 (A4–A1, BW = 0) or 1010x (A4–A0, BW = 1). The corresponding flag in the Interrupt Status register goes high ("1") any time that an interrupt condition takes place, whether an interrupt is enabled or disabled in the Interrupt Enable register. Any of the active ("1") Interrupt Status register flags are reset to "0" whenever this register is read or a device reset is issued (see Bit 1 in the Configuration Register).

Bit 0 is set to "1" when a "watchdog" comparison limit interrupt has taken place.

**Bit 1** is set to "1" when the Sequencer has reached the address stored in Bits 8–10 of the Interrupt Enable register.

**Bit 2** is set to "1" when the Conversion FIFO's limit, stored in Bits 11–15 of the Interrupt Enable register, has been reached.

Bit 3 is set to "1" when the single-sampled auto-zero has been completed.

Bit 4 is set to "1" when an auto-zero and full linearity self-calibration has been completed.

Bit 5 is set to "1" when a Pause interrupt has been generated.

Bit 6 is set to "1" when a low-supply voltage condition  $(V_{\rm A}+<4V)$  has taken place.

**Bit 7** is set to "1" when the LM12(H)454/8 return from power-down to active mode.

**Bits 8–10** hold the Sequencer's actual instruction address while it is running.

**Bits 11–15** hold the actual number of conversions stored in the Conversion FIFO while the Sequencer is running.

#### 2.6 LIMIT STATUS REGISTER

The read-only register is located at address 1101 (A4–A1, BW = 0) or 1101x (A4–A0, BW = 1). This register is used in tandem with the Limit #1 and Limit #2 registers in the Instruction RAM. Whenever a given instruction's input voltage exceeds the limit set in its corresponding Limit register (#1 or #2), a bit, corresponding to the instruction number, is set in the Limit Status register. Any of the active ("1") Limit Status flags are reset to "0" whenever this register is read or a device reset is issued (see Bit 1 in the Configuration register). This register holds the status of limits #1 and #2 for each of the eight instructions.

**Bits 0–7** show the Limit #1 status. Each bit will be set high ("1") when the corresponding instruction's input voltage exceeds the threshold stored in the instruction's Limit #1 register. When, for example, instruction 3 is a "watchdog" operation (Bit 11 is set high) and the input for instruction 3 meets the magnitude and/or polarity data stored in instruction 3's Limit #1 register, Bit 3 in the Limit Status register will be set to a "1".

# 2.0 Internal User-Programmable Registers (Continued)

Bits 8–15 show the Limit #2 status. Each bit will be set high ("1") when the corresponding instruction's input voltage exceeds the threshold stored in the instruction's Limit #2 register. When, for example, the input to instruction 6 meets the value stored in instruction 6's Limit #2 register, Bit 14 in the Limit Status register will be set to a "1".

#### 2.7 TIMER

The LM12(H)454/8 have an on-board 16-bit timer that includes a 5-bit pre-scaler. It uses the clock signal applied to pin 23 as its input. It can generate time intervals of 0 through  $2^{21}$  clock cycles in steps of  $2^{5}$ . This time interval can be used to delay the execution of instructions. It can also be used to slow the conversion rate when converting slowly changing signals. This can reduce the amount of redundant data stored in the FIFO and retrieved by the controller.

The user-defined timing value used by the Timer is stored in the 16-bit READ/WRITE Timer register at location 1011 (A4–A1, BW = 0) or 1011x (A4–A0, BW = 1) and is pre-loaded automatically. Bits 0–7 hold the preset value's low byte and Bits 8–15 hold the high byte. The Timer is activated by the Sequencer only if the current instruction's Bit 9 is set ("1"). If the equivalent decimal value "N" ( $0 \le N \le 2^{16} - 1$ ) is written inside the 16-bit Timer register and the Timer is enabled by setting an instruction's bit 9 to a "1", the Sequencer will delay the same instruction's execution by halting at state 3 (S3), as shown in *Figure 15*, for 32 x N + 2 clock cycles.

#### 2.8 DMA

The DMA works in tandem with Interrupt 2. An active DMA Request on pin 32 (DMARQ) requires that the FIFO interrupt be enabled. The voltage on the DMARQ pin goes high when the number of conversions in the FIFO equals the 5-bit value stored in the Interrupt Enable register (bits 11–15). The voltage on the INT pin goes low at the same time as the voltage on the DMARQ pin goes high. The voltage on the DMARQ pin goes low when the FIFO is emptied. The Interrupt Status register must be read to clear the FIFO interrupt flag in order to enable the next DMA request.

DMA operation is optimized through the use of the 16-bit databus connection (a logic "0" applied to the BW pin). Using this bus width allows DMA controllers that have single address Read/Write capability to easily unload the FIFO. Using DMA on an 8-bit databus is more difficult. Two read operations (low byte, high byte) are needed to retrieve each conversion result from the FIFO. Therefore, the DMA controller must be able to repeatedly access two constant addresses when transferring data from the LM12(H)454/8 to the host system.

# 3.0 FIFO

The result of each conversion stored in an internal read-only FIFO (First-In, First-Out) register. It is located at 1100 (A4–A1, BW = 0) or 1100x (A4–A0, BW = 1). This register has 32 16-bit wide locations. Each location holds 13-bit data. Bits 0–3 hold the four LSB's in the 12 bits + sign mode or "1110" in the 8 bits + sign mode. Bits 4–11 hold the eight MSB's and Bit 12 holds the sign bit. Bits 13–15 can hold either the sign bit, extending the register's two's complement data format to a full sixteen bits or the instruction address

that generated the conversion and the resulting data. These modes are selected according to the logic state of the Configuration register's Bit 5.

The FIFO status should be read in the Interrupt Status register (Bits 11–15) to determine the number of conversion results that are held in the FIFO before retrieving them. This will help prevent conversion data corruption that may take place if the number of reads are greater than the number of conversion results contained in the FIFO. Trying to read the FIFO when it is empty may corrupt new data being written into the FIFO. Writing more than 32 conversion data into the FIFO by the ADC results in loss of the first conversion data. Therefore, to prevent data loss, it is recommended that the LM12(H)454/8's interrupt capability be used to inform the system controller that the FIFO is full.

The lower portion (A0 = 0) of the data word (Bits 0–7) should be read first followed by a read of the upper portion (A0 = 1)when using the 8-bit bus width (BW = 1). Reading the upper portion first causes the data to shift down, which results in loss of the lower byte.

Bits 0–12 hold 12-bit + sign conversion data. Bits 0–3 will be 1110 (LSB) when using 8-bit plus sign resolution.

Bits 13–15 hold either the instruction responsible for the associated conversion data or the sign bit. Either mode is selected with Bit 5 in the Configuration register.

Using the FIFO's full depth is achieved as follows. Set the value of the Interrupt Enable register's Bits 11-15 to 11111 and the Interrupt Enable register's Bit 2 to a "1". This generates an external interrupt when the 31st conversion is stored in the FIFO. This gives the host processor a chance to send a "0" to the LM12(H)454/8's Start bit (Configuration register) and halt the ADC before it completes the 32nd conversion. The Sequencer halts after the current (32) conversion is completed. The conversion data is then transferred to the FIFO and occupies the 32nd location. FIFO overflow is avoided if the Sequencer is halted before the start of the 32nd conversion by placing a "0" in the Start bit (Configuration register). It is important to remember that the Sequencer continues to operate even if a FIFO interrupt (INT 2) is internally or externally generated. The only mechanisms that stop the Sequencer are an instruction with the PAUSE bit set to "1" (halts before instruction execution), placing a "0" in the Configuration register's START bit, or placing a "1" in the Configuration register's RESET bit.

# 4.0 Sequencer

The Sequencer uses a 3-bit counter (Instruction Pointer, or IP, in Figure 9) to retrieve the programmable conversion instructions stored in the Instruction RAM. The 3-bit counter is reset to 000 during chip reset or if the current executed instruction has its Loop bit (Bit 1 in any Instruction RAM "00") set high ("1"). It increments at the end of the currently executed instruction and points to the next instruction. It will continue to increment up to 111 unless an instruction's Loop bit is set. If this bit is set, the counter resets to "000" and execution begins again with the first instruction. If all instructions have their Loop bit reset to "0", the Sequencer will execute all eight instructions continuously. Therefore, it is important to realize that if less than eight instructions are programmed, the Loop bit on the last instruction must be set. Leaving this bit reset to "0" allows the Sequencer to execute "unprogrammed" instructions, the results of which may be unpredictable.

The Sequencer's Instruction Pointer value is readable at any time and is found in the Status register at Bits 8–10. The Sequencer can go through eight states during instruction execution:

State 0: The current instruction's first 16 bits are read from the Instruction RAM "00". This state is one clock cycle long.

**State 1:** Checks the state of the Calibration and Start bits. This is the "rest" state whenever the Sequencer is stopped using the reset, a Pause command, or the Start bit is reset low ("0"). When the Start bit is set to a "1", this state is one clock cycle long.

State 2: Perform calibration. If bit 2 or bit 6 of the Configuration register is set to a "1", state 2 is 76 clock cycles long. If the Configuration register's bit 3 is set to a "1", state 2 is 4944 clock cycles long. **State 3:** Run the internal 16-bit Timer. The number of clock cycles for this state varies according to the value stored in the Timer register. The number of clock cycles is found by using the expression below

#### 32T + 2

where  $0 \le T \le 2^{16} - 1$ .

**State 7:** Run the acquisition delay and read Limit #1's value if needed. The number of clock cycles for 12-bit + sign mode varies according to

#### 9 + 2D

where D is the user-programmable 4-bit value stored in bits 12–15 of Instruction RAM "00" and is limited to  $0 \le D \le 15$ . The number of clock cycles for 8-bit + sign or "watchdog" mode varies according to

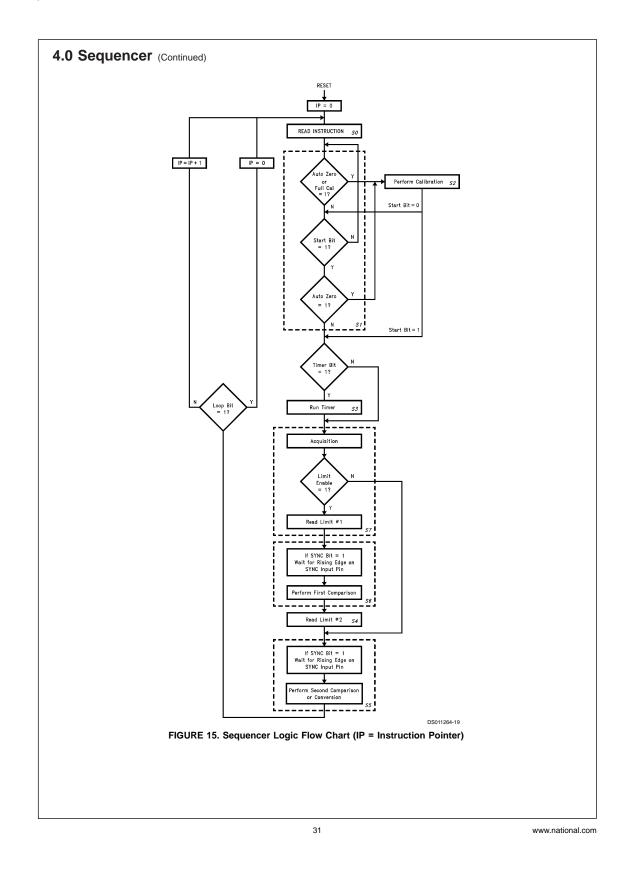
#### 2 + 2D

where D is the user-programmable 4-bit value stored in bits 12–15 of Instruction RAM "00" and is limited to  $0 \le D \le 15$ .

State 6: Perform first comparison. This state is 5 clock cycles long.

State 4: Read Limit #2. This state is 1 clock cycle long.

**State 5:** Perform a conversion or second comparison. This state takes 44 clock cycles when using the 12-bit + sign mode or 21 clock cycles when using the 8-bit + sign mode. The "watchdog" mode takes 5 clock cycles.



# 5.0 Analog Considerations

## 5.1 REFERENCE VOLTAGE

The difference in the voltages applied to the V<sub>REF+</sub> and V<sub>REF-</sub> defines the analog input voltage span (the difference between the voltages applied between two multiplexer inputs or the voltage applied to one of the multiplexer inputs and analog ground), over which 4095 positive and 4096 negative codes exist. The voltage sources driving V<sub>REF+</sub> or V<sub>REF-</sub> must have very low output impedance and noise.

The ADC can be used in either ratiometric or absolute reference applications. In ratiometric systems, the analog input voltage is proportional to the voltage used for the ADC's reference voltage. When this voltage is the system power supply, the V<sub>REF+</sub> pin is connected to V<sub>A</sub>+ and V<sub>REF-</sub> is connected to GND. This technique relaxes the system reference stability requirements because the analog input voltage and the ADC reference voltage move together. This maintains the same output code for given input conditions.

For absolute accuracy, where the analog input voltage varies between very specific voltage limits, a time and temperature stable voltage source can be connected to the reference inputs. Typically, the reference voltage's magnitude will require an initial adjustment to null reference voltage induced full-scale errors.

When using the LM12(H)454/8's internal 2.5V bandgap reference, a parallel combination of a 100  $\mu F$  capacitor and a 0.1  $\mu F$  capacitor connected to the  $V_{REFOUT}$  pin is recommended for low noise operation. When left unconnected, the reference remains stable without a bypass capacitor. However, ensure that stray capacitance at the  $V_{REFOUT}$  pin remains below 50 pF.

#### 5.2 INPUT RANGE

The LM12(H)454/8's fully differential ADC and reference voltage inputs generate a two's-complement output that is found by using the equation below.

output code = 
$$\frac{V_{IN+} - V_{IN-}}{V_{REF+} - V_{REF-}}$$
 (4096) -  $\frac{1}{2}$  (12-bit)

output code = 
$$\frac{V_{IN+} - V_{IN-}}{V_{REF+} - V_{REF-}} (256) - \frac{1}{2}$$
(8-bit)

Round up to the next integer value between -4096 to 4095 for 12-bit resolution and between -256 to 255 for 8-bit resolution if the result of the above equation is not a whole number. As an example,  $V_{REF+} = 2.5V$ ,  $V_{REF-} = 1V$ ,  $V_{IN+} = 1.5V$  and  $V_{IN-} = GND$ . The 12-bit + sign output code is positive full-scale, or 0,1111,1111. If  $V_{REF+} = 5V$ ,  $V_{REF-} = 1V$ ,  $V_{IN+} = 3V$ , and  $V_{IN-} = GND$ , the 12-bit + sign output code is 0,1100,0000,0000.

#### **5.3 INPUT CURRENT**

A charging current flows into or out of (depending on the input voltage polarity) the analog input pins, IN0–IN7 at the start of the analog input acquisition time ( $t_{ACQ}$ ). This current's peak value will depend on the actual input voltage applied.

#### 5.4 INPUT SOURCE RESISTANCE

For low impedance voltage sources (<100 $\Omega$  for 5 MHz operation and <60 $\Omega$  for 8 MHz operation), the input charging current will decay, before the end of the S/H's acquisition time, to a value that will not introduce any conversion errors. For higher source impedances, the S/H's acquisition time

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can be increased. As an example, operating with a 5 MHz clock frequency and maximum acquisition time, the LM12(H)454/8's analog inputs can handle source impedance as high as 6.67 k $\Omega$ . When operating at 8 MHz and maximum acquisition time, the LM12H454/8's analog inputs can handle source impedance as high as 4.17 k $\Omega$ . Refer to Section 2.1, Instruction RAM "00", Bits 12–15 for further information.

### 5.5 INPUT BYPASS CAPACITANCE

External capacitors (0.01  $\mu F{-}0.1$   $\mu F)$  can be connected between the analog input pins, IN0–IN7, and analog ground to filter any noise caused by inductive pickup associated with long input leads. It will not degrade the conversion accuracy.

#### 5.6 NOISE

The leads to each of the analog multiplexer input pins should be kept as short as possible. This will minimize input noise and clock frequency coupling that can cause conversion errors. Input filtering can be used to reduce the effects of the noise sources.

#### 5.7 POWER SUPPLIES

Noise spikes on the V<sub>A</sub>+ and V<sub>D</sub>+ supply lines can cause conversion errors; the comparator will respond to the noise. The ADC is especially sensitive to any power supply spikes that occur during the auto-zero or linearity correction. Low inductance tantalum capacitors of 10 µF or greater paralleled with 0.1 µF monolithic ceramic capacitors are recommended for supply bypassing. Separate bypass capacitors should be used for the V<sub>A</sub> + and V<sub>D</sub>+ supplies and placed as close as possible to these pins.

### 5.8 GROUNDING

The LM12(H)454/8's nominal high resolution performance can be maximized through proper grounding techniques. These include the use of separate analog and digital ground planes. The digital ground plane is placed under all components that handle digital signals, while the analog ground plane is placed under all analog signal handling circuitry. The digital and analog ground planes are connected at only one point, the power supply ground. This greatly reduces the occurrence of ground loops and noise.

It is recommended that stray capacitance between the analog inputs or outputs (LM12(H)454: IN0–IN3, MUXOUT+, MUXOUT-, S/H IN+, S/H IN-; LM12(H)458: IN0–IN7,  $V_{\rm REF+}$ , and  $V_{\rm REF-}$ ) be reduced by increasing the clearance (+1/16th inch) between the analog signal and reference pins and the ground plane.

#### 5.9 CLOCK SIGNAL LINE ISOLATION

The LM12(H)454/8's performance is optimized by routing the analog input/output and reference signal conductors (pins 34–44) as far as possible from the conductor that carries the clock signal to pin 23. Ground traces parallel to the clock signal trace can be used on printed circuit boards to reduce clock signal interference on the analog input/output pins.

# 6.0 Application Circuits

#### PC EVALUATION/INTERFACE BOARD

*Figure 16* is the schematic of an evaluation/interface board designed to interface the LM12(H)454 or LM12(H)458 with an XT or AT<sup>®</sup> style computer. The board can be used to de-

# 6.0 Application Circuits (Continued)

velop both software and hardware. The board hardwires the BW (Bus Width) pin to a logic high, selecting an 8-bit wide databus. Therefore, it is designed for an 8-bit expansion slot on the computer's motherboard.

The circuit operates on a single +5V supply derived from the computer's +12V supply using an LM340 regulator. This greatly attenuates noise that may be present on the computer's power supply lines. However, your application may only need an LC filter.

*Figure 16* also shows the recommended supply (V<sub>A</sub>+ and V<sub>D</sub>+) and reference input (V<sub>REF+</sub> and V<sub>REF-</sub>) bypassing. The digital and analog supply pins can be connected together to the same supply voltage. However, they need separate, multiple bypass capacitors. Multiple capacitors on the supply pins and the reference inputs ensures a low impedance bypass path over a wide frequency range.

All digital interface control signals (IOR, IOW, and AEN), data lines (DBO–DB7), address lines (AO–A9), and IRQ (interrupt request) lines (IRQ2, IRQ3, and IRQ5) connections are made through the motherboard slot connector. All analog signals applied to, or received by, the input multiplexer (INO–IN7 for the LM12(H)458 and INO–IN3, MUXOUT+, MUXOUT-, S/H IN+ and S/H IN– for the LM12(H)454),  $V_{REF+}$ ,  $V_{REF-UT}$ , and the SYNC signal input/ output are applied through a DB-37 connector on the rear side of the board. *Figure 16* shows that there are numerous analog ground connections available on the DB-37 connector.

The voltage applied to  $V_{REF-}$  and  $V_{REF+}$  is selected using two jumpers, JP1 and JP2. JP1 selects between the voltage applied to the DB-37's pin 24 or GND and applies it to the LM12(H)454/8's  $V_{REF-}$  input. JP2 selects between the LM12(H)454/8's internal reference output,  $V_{REFOUT}$ , and the voltage applied to the DB-37's pin 22 and applies it to the LM12(H)454/8's  $V_{REF+}$  input.

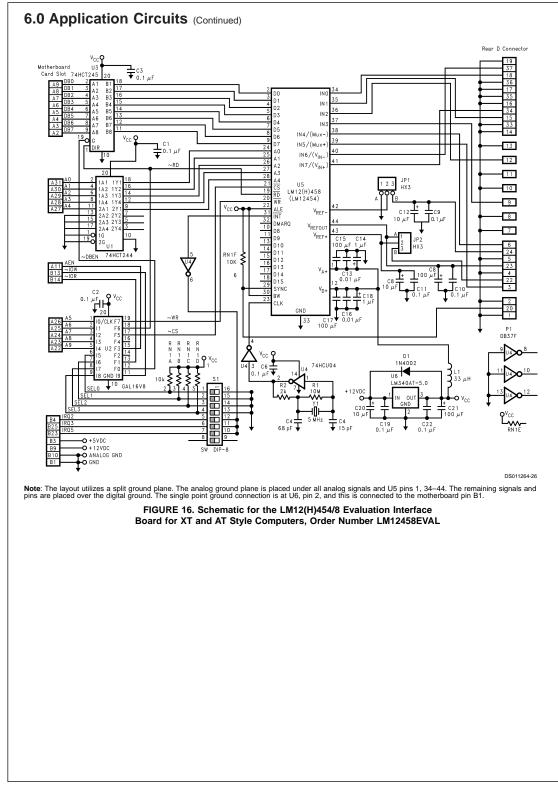
Hexidecimal I/O Memory		SWI	DIP-8	
Base Address	SW1	SW2	SW3	SW4
	(SEL0)	(SEL1)	(SEL2)	(SEL3)
100	ON	ON	ON	ON
120	OFF	ON	ON	ON
140	ON	OFF	ON	ON
160	OFF	OFF	ON	ON
180	ON	ON	OFF	ON
1A0	OFF	ON	OFF	ON
1C0	ON	OFF	OFF	ON
300	OFF	OFF	OFF	ON
340	ON	ON	ON	OFF
280	OFF	ON	ON	OFF
2A0	ON	OFF	ON	OFF

TABLE 3. LM12(H)454/8 Evaluation/Interface

The board allows the use of one of three Interrupt Request (IRQ) lines IRQ2, IRQ3, and IRQ5. The individual IRQ line can be selected using switches 5, 6, and 7 of SW DIP-8. When using any of these three IRQs, the user needs to ensure that there are no conflicts between the evaluation board and any other boards attached to the computer's motherboard.

Switches 1–4, along with address lines A5–A9 are used as inputs to GAL16V8 Programmable Gate Array (U2). This device forms the interface between the computer's control and address lines and generates the control signals used by the LM12(H)454/8 for  $\overline{CS}$ ,  $\overline{WR}$ , and  $\overline{RD}$ . It also generates the signal that controls the data buffers. Several address ranges within the computer's I/O memory map are available. Refer to Table III for the switch settings that gives the desired I/O memory address range. Selection of an address range must be done so that there are no conflicts between the evaluation board and only other boards attached to the computer's R. The GAL functional block diagram is shown in *Figure 19*.

*Figures 20, 21, 22, 23* show the layout of each layer in the 3-layer evaluation/interface board plus the silk-screen layout showing parts placement. *Figure 21* is the top or component side, *Figure 22* is the middle or ground plane layer, *Figure 23* is the circuit side, and *Figure 20* is the parts layout.



# 6.0 Application Circuits (Continued)

Parts Lis	t:
Y1	HC49U, 8 MHz crystal
D1	1N4002
L1	33 µH
P1	DB37F; parallel connector
R1	10 MΩ, 5%, ¼W
R2	2 kΩ, 5%, ¼W
RN1	10 kΩ, 6 resistor SIP, 5%, 1/8W
JP1, JP2	HX3, 3-pin jumper
S1	SW DIP-8; 8 SPST switches
C1–3, C6	5, C9–11,
C19, C22	0.1 µF, 50V, monolithic ceramic
C4	68 pF, 50V, ceramic disk
C5	15 pF, 50V, ceramic disk
C7, C21	100 μF, 25V, electrolytic
	C20 10 µF, 35V, electrolytic
C13, C16	•
C14, C18	
C15, C17	
U1	MM74HCT244N
U2	GAL16V8-20LNC
U3 U4	MM74HCT245N MM74HCU04N
U5	LM12(H)458CIV or LM12454CIV
U6	LM340AT-5.0
SK1	44-pin PLCC socket
A1	LM12(H)458/4 Rev. D PC Board
	FIGURE 17. Parts List for the LM12(H)454/8 Evaluation Interface
	Board for XT and AT Style Computers, Order Number LM12458EVAL

# 6.0 Application Circuits (Continued)

;I/O Decode Lines io\_A5 1 2 io\_A6 ā io\_A7 1 o\_A8 io\_A9 5 ;Select Lines for Zone Decode SELO SEL1 SEL2 8 ğ SEL3 ;Physical I/O Controls 15 AEN !io\_WR !io\_RD 11 13 ;Physical Outputs fCS fWR 17 19 RD 18 12 **! DBEN** ;Intermediate Terms: 16 14 DECØ FILT Equations Decode of Select Lines: 
 !SEL2
 & !SEL1
 & !SEL0;

 !SEL2
 & !SEL1
 & SEL0;

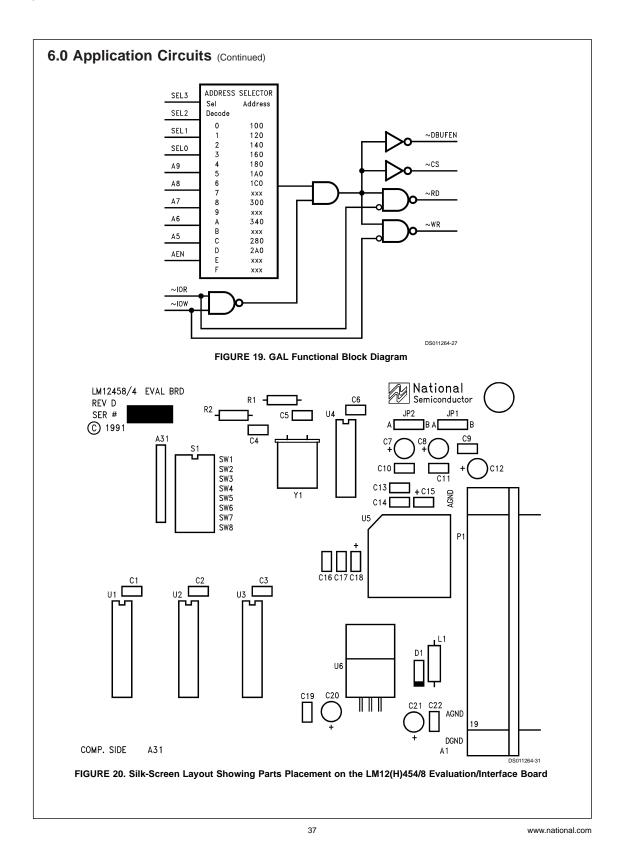
 !SEL2
 & SEL1
 & SEL0;
 SLØ -SL1 -SL2 SL3 -SEL2 & ISEL1 & SEL0; SEL2 & ISEL1 & SEL0; SEL2 & ISEL1 & SEL0; SEL2 & SEL1 & ISEL0; SEL2 & SEL1 & SEL0; SL4 -SL5 -SL6 SL7 . Decode of Address Lines: ess Lines: SL0 & !io\_A7 & !io\_A6 & !io\_A5; SL1 & !io\_A7 & !io\_A6 & io\_A5; SL2 & !io\_A7 & io\_A6 & !io\_A5; SL3 & !io\_A7 & io\_A6 & !o\_A5; SL4 & io\_A7 & !io\_A6 & !o\_A5; SL5 & io\_A7 & !io\_A6 & !o\_A5; SL6 & io\_A7 & io\_A6 & !o\_A5; AL00 --AL20 AL40 -AL60 -AL80 . -ALA0 ALCO - 
 \*SEL3 & fio\_A9 & io\_A8;

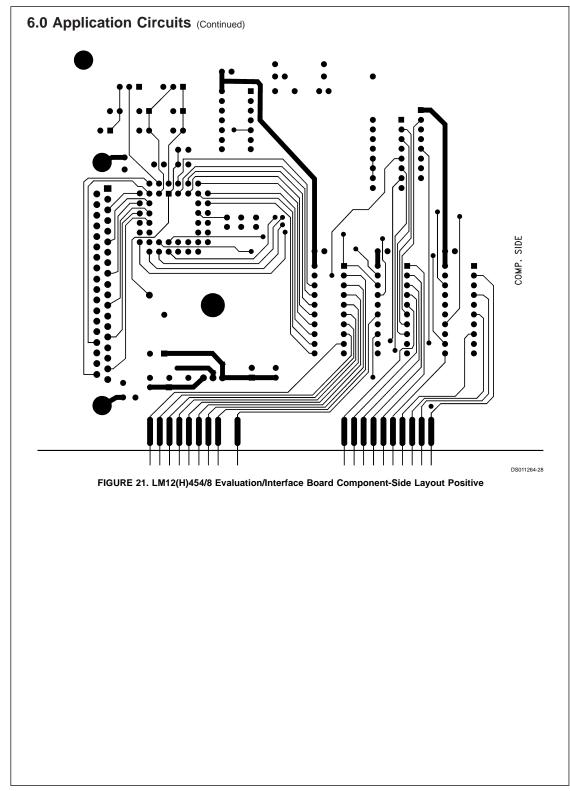
 SEL3 & io\_A9 & fio\_A8 & io\_A7 & fio\_A6;

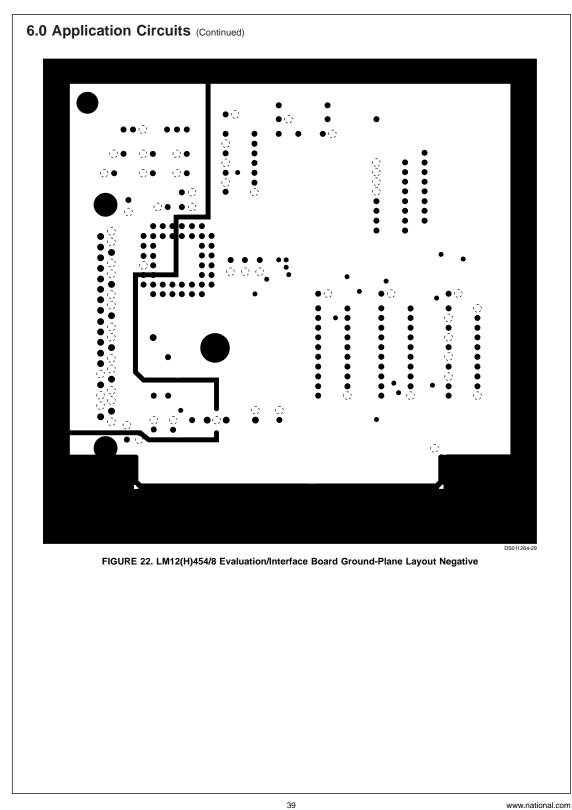
 SEL3 & io\_A9 & fio\_A8 & fio\_A7 & fio\_A5;

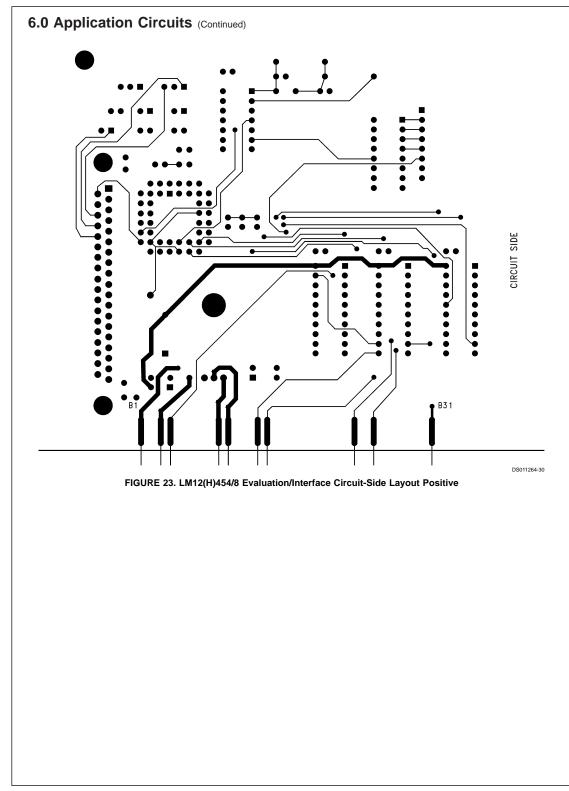
 SEL3 & io\_A9 & foo\_A8 & fio\_A7 & fio\_A5;
 AHØ1 --AH02 AH03 -;Intermediate Address Groups: DEC0 - !AEN & (AL00 + AL20 + AL40 + AL50 + AL80 + ALA0 + ALC0); DECØ ;DAS Chip Select Decode; FILT - CS & ( i FILT CS DBEN = ;Delayed Read/ Write Decodes: io\_WR & FILT; io\_RD & FILT; ŴŔ RD . DS011264-32 FIGURE 18. Logic Equations Used to Program the GAL16V8

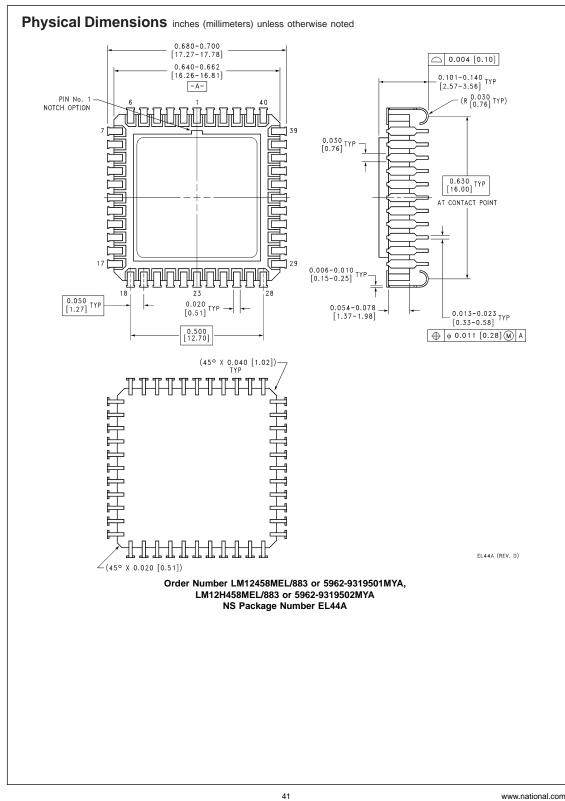
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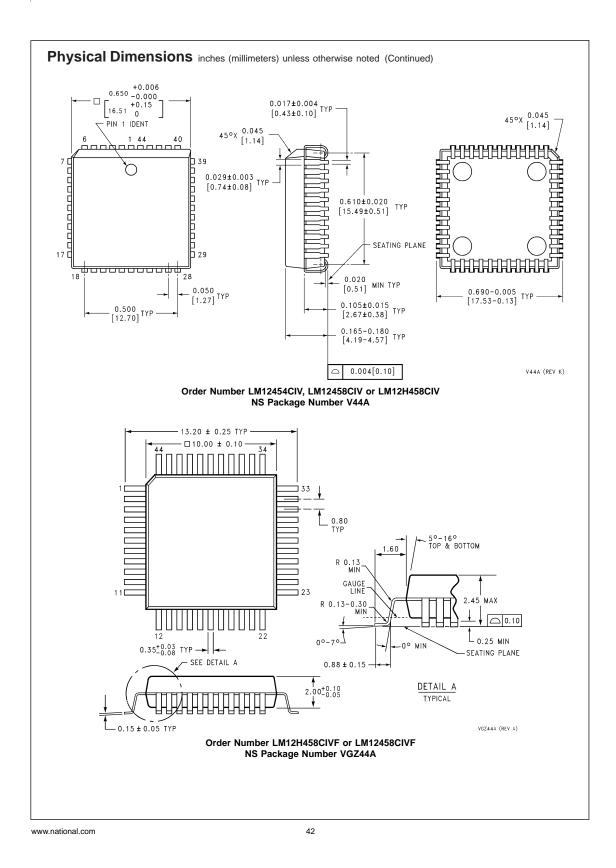












	Notes		i	12-E
				LM12454/LM12458/LM12H458 12-Bit + Sign Data Acquisitio
				4/LN Sig
				n Da
				58/L
			-	.M12
				2458/LM12H458 Data Acquisition
				System with
				em v
				vith
				Sel
				Self-Calibration
				libra
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